Annex A: Probe sensitivity and reference signal measurement plots

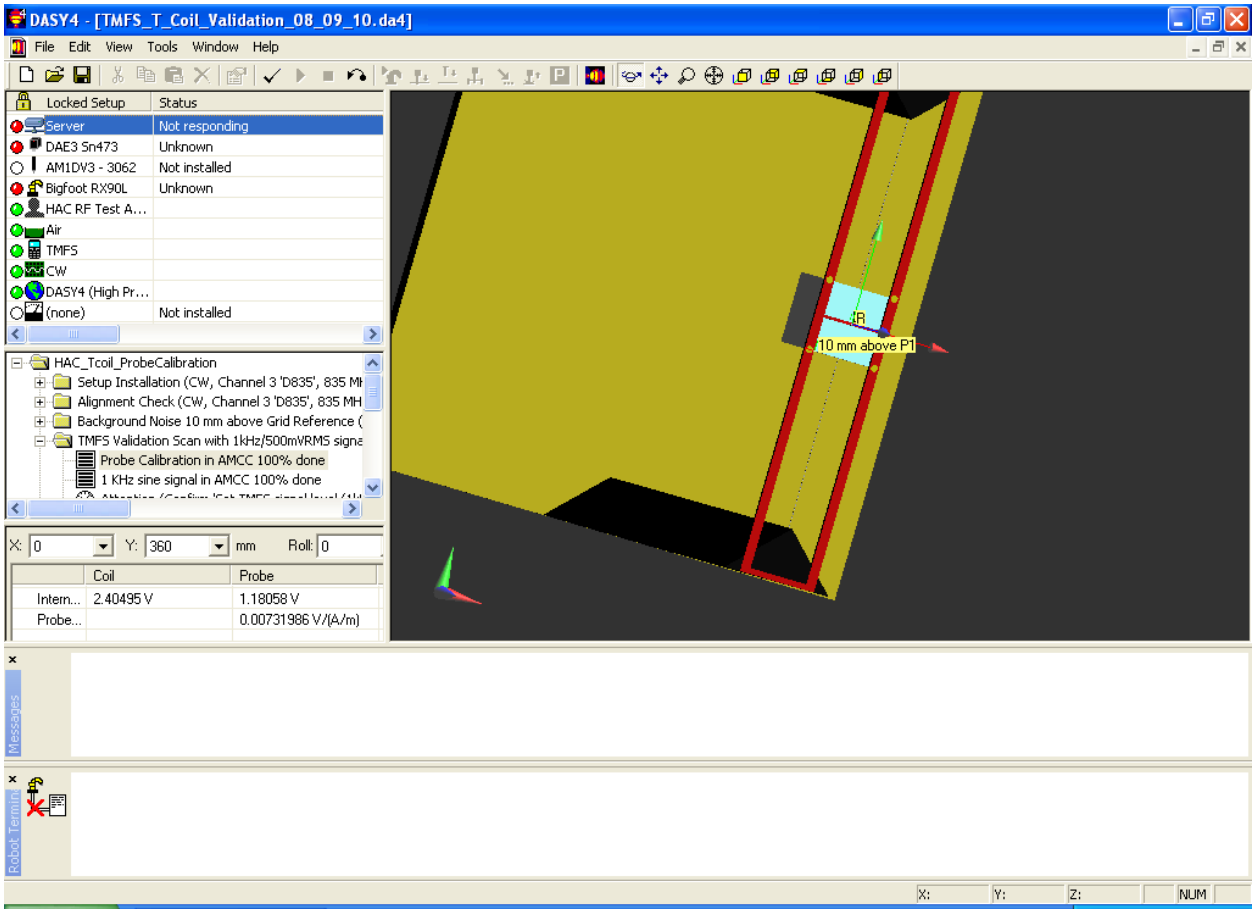


Figure A1: Probe calibration data for coil and probe

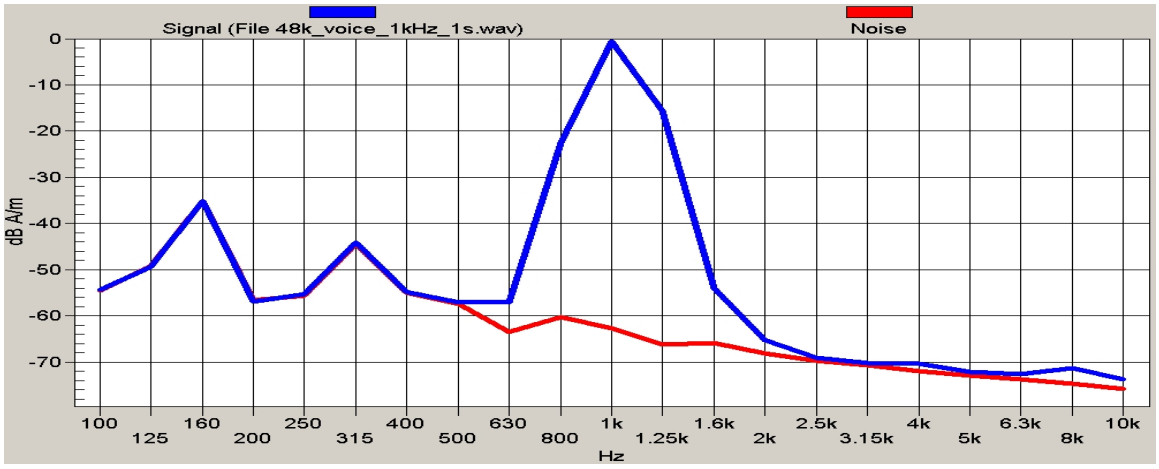


Figure A2: Reference voice 1 kHz signal and noise

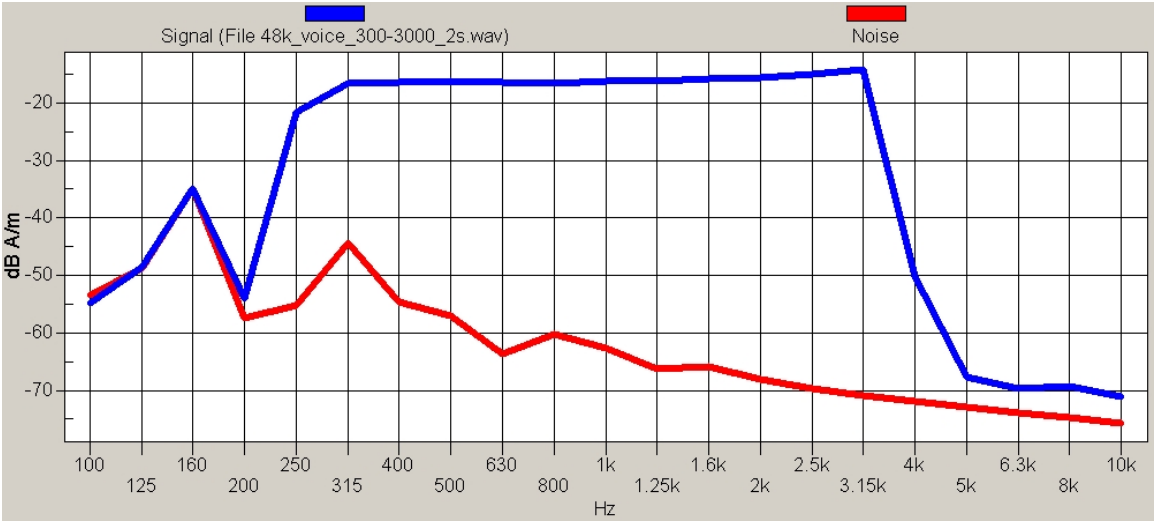


Figure A3: Reference voice simulated signal and noise

Annex B: TMFS system validation and ambient data/plots

Date/Time: 8/9/2010 11:51:55 AM

Test Laboratory: RIM Testing Services

TMFS_T_Coil_Validation_08_09_10

DUT: TMFS; Type: Sample

Communication System: CW; Frequency: 835 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

Background Noise 10 mm above Grid Reference/z (axial) noise/ABM Noise(x,y,z) (1x1x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Off

Output Gain: 100

Measure Window Start: 2000ms

Measure Window Length: 5000ms

Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM2 = -49.6 dB A/m
Location: 0, 0, 13 mm

Background Noise 10 mm above Grid Reference/z (axial) noise/ABM Noise Spectrum(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Off
Output Gain: 100
Measure Window Start: 2000ms
Measure Window Length: 5000ms
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM = -49.6 dB A/m
Location: 0, 0, 13 mm

Background Noise 10 mm above Grid Reference/x (longitudinal) noise/ABM Noise Spectrum(x,y,z,f) (1x1x1):

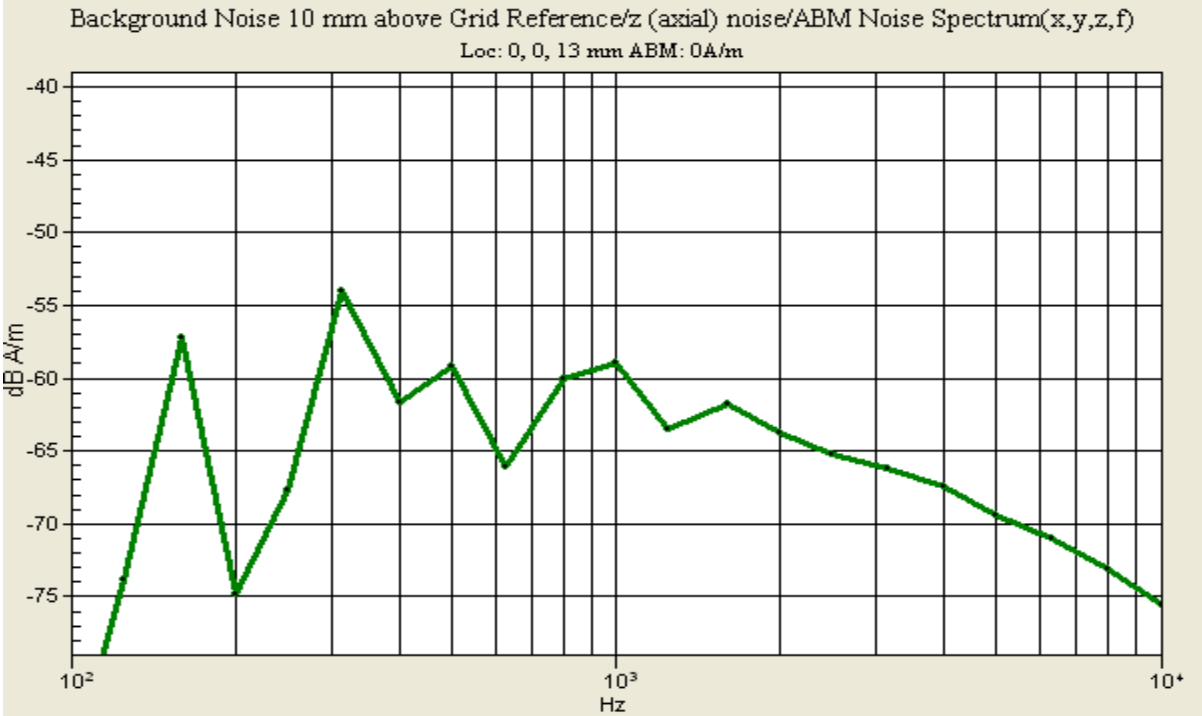
Measurement grid: dx=10mm, dy=10mm
Signal Type: Off
Output Gain: 100
Measure Window Start: 2000ms
Measure Window Length: 5000ms
Device Reference Point: 0.000, 0.000, -6.30 mm

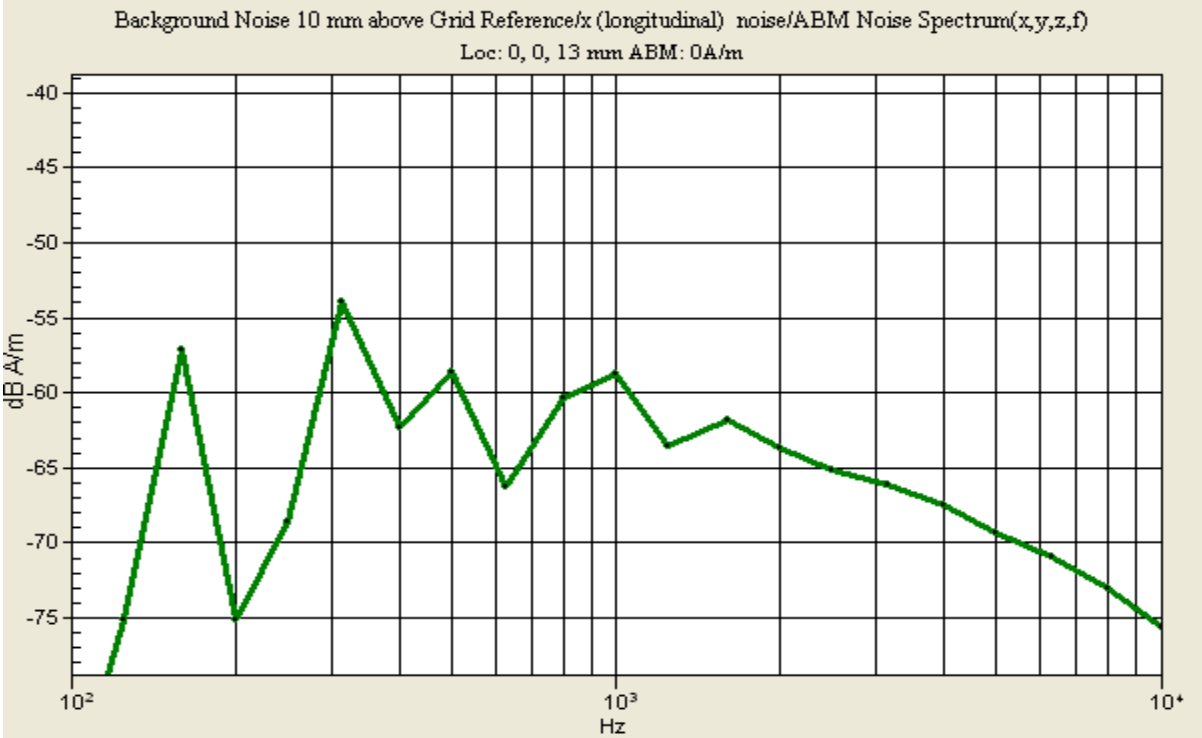
Cursor:

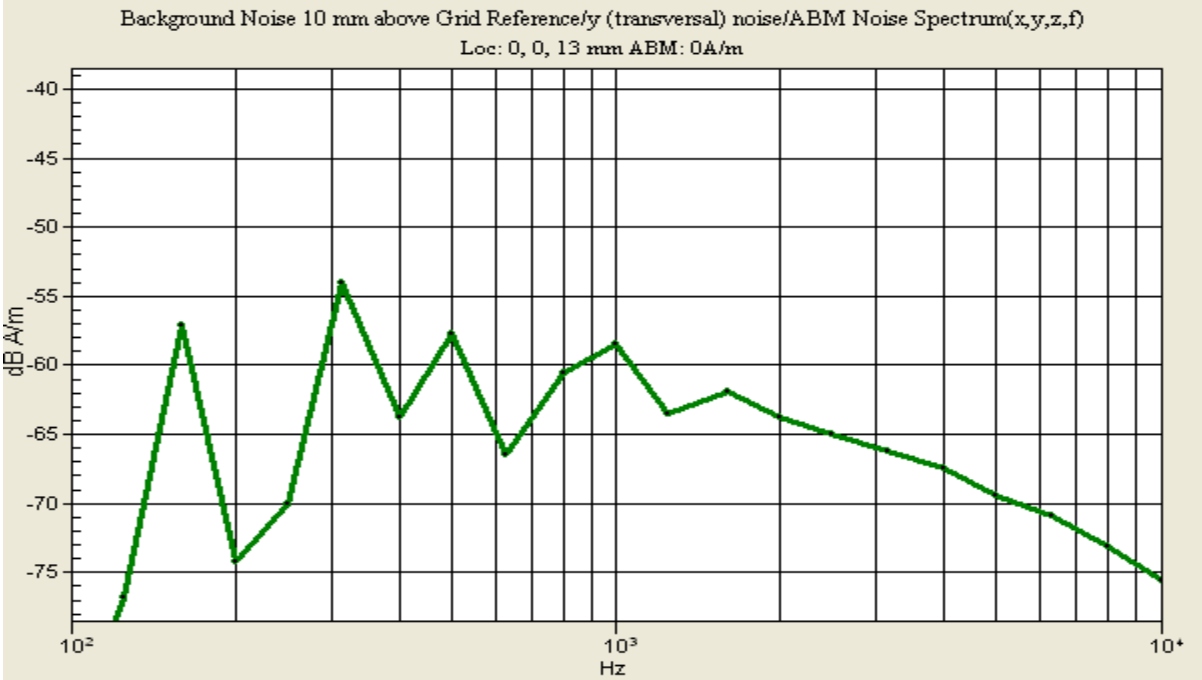
ABM = -49.5 dB A/m
Location: 0, 0, 13 mm

Background Noise 10 mm above Grid Reference/y (transversal) noise/ABM Noise Spectrum(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Off
Output Gain: 100
Measure Window Start: 2000ms
Measure Window Length: 5000ms
Device Reference Point: 0.000, 0.000, -6.30 mm







Date/Time: 8/9/2010 11:55:20 AM

Test Laboratory: RIM Testing Services

TMFS_T_Coil_Validation_08_09_10_Axial

DUT: TMFS; Type: Sample

Communication System: CW; Frequency: 835 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

TMFS Validation Scan with 1kHz/500mVRMS signal level/W z (axial) 50 x 50 step 2/ABM Signal(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: 1 kHz Sine

Output Gain: 35.05

Measure Window Start: 300ms

Measure Window Length: 4000ms

BWC applied: -0.0108033 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

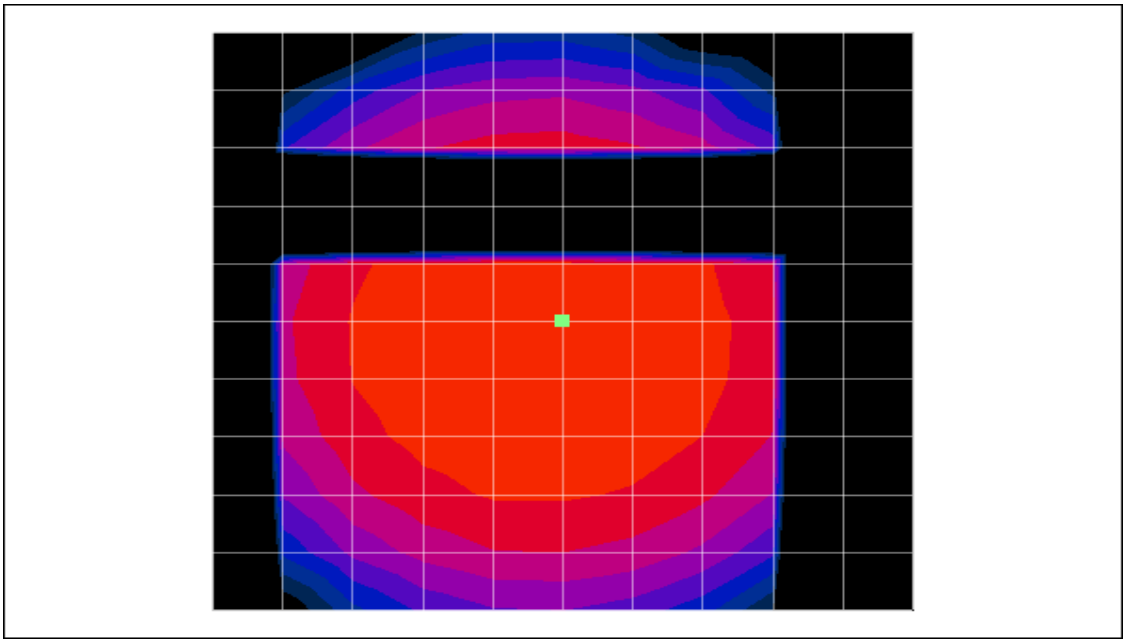
ABM1 comp = -20.3 dB A/m
BWC Factor = -0.0108033 dB
Location: 0, 0, 3 mm

Frequency response measurement/Multisine reference signal/ABM Freq Resp(x,y,z,f) (1x1x1):

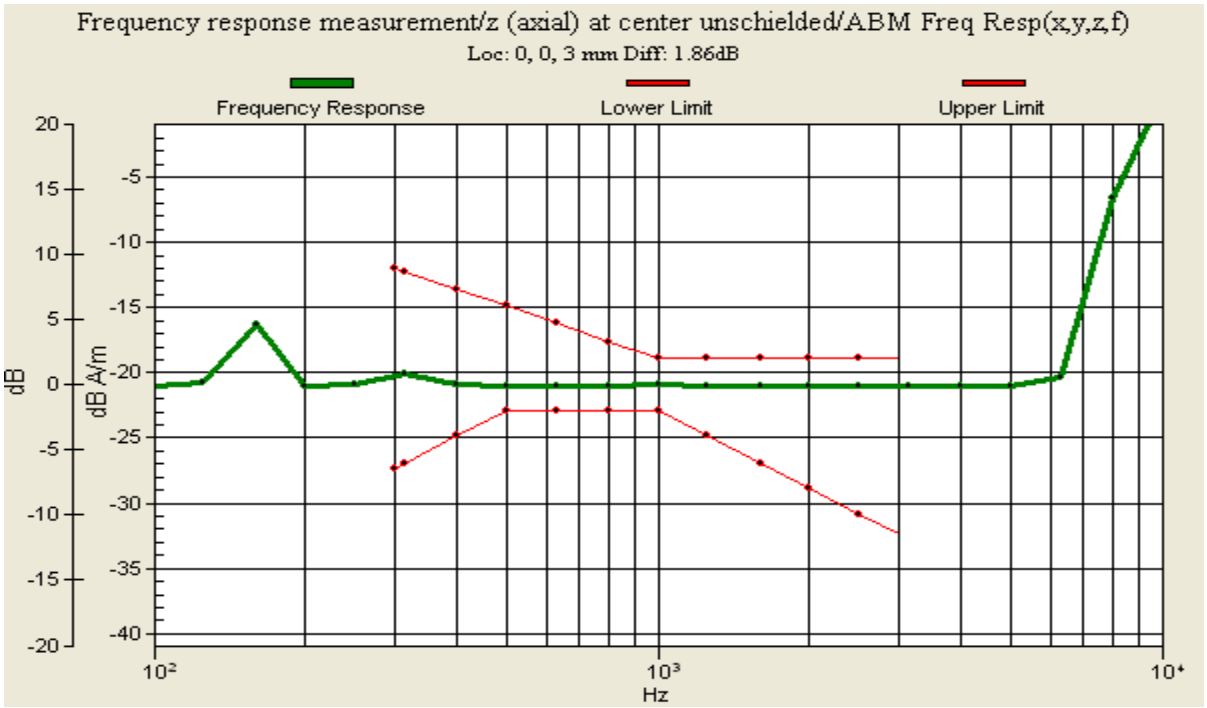
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_multisine_50-5000_10s.wav
Output Gain: 80
Measure Window Start: 2000ms
Measure Window Length: 5000ms
Device Reference Point: 0.000, 0.000, -6.30 mm

Frequency response measurement/z (axial) at center unschielded/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_multisine_50-5000_10s.wav
Output Gain: 87.2
Measure Window Start: 2000ms
Measure Window Length: 5000ms
BWC applied: 12.5 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00A/m



Date/Time: 8/9/2010 12:12:16 PM

Test Laboratory: RIM Testing Services

TMFS_T_Coil_Validation_08_09_10_Radial_L

DUT: TMFS; Type: Sample

Communication System: CW; Frequency: 835 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

TMFS Validation Scan with 1kHz/500mVRMS signal level/W x (longitudinal) 50 x 50 step 4/ABM Signal(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: 1 kHz Sine

Output Gain: 35.05

Measure Window Start: 300ms

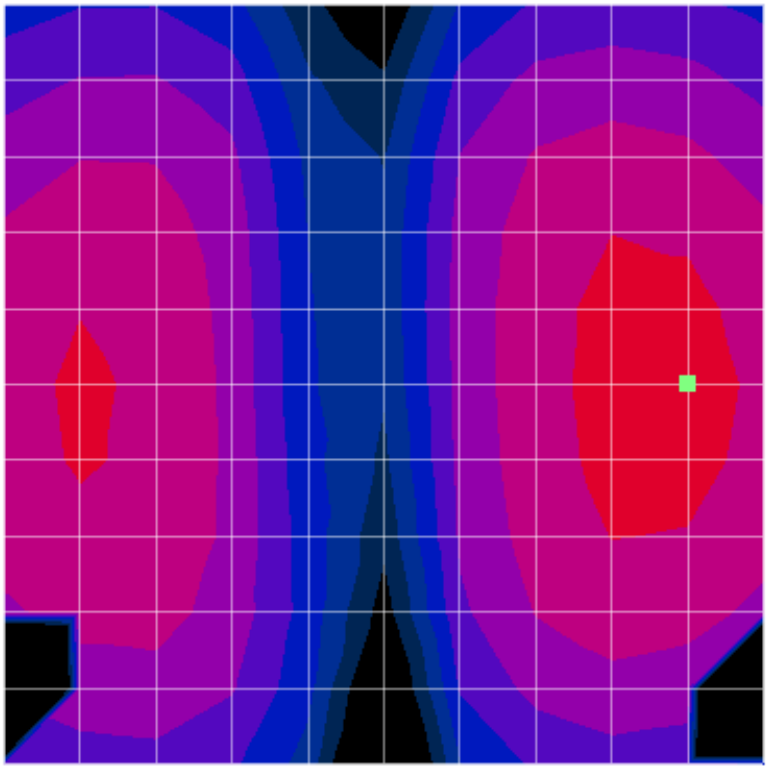
Measure Window Length: 4000ms

BWC applied: -0.0108033 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1 comp = -25.3 dB A/m
BWC Factor = -0.0108033 dB
Location: -20, 0, 3 mm



0 dB = 1.00A/m

Date/Time: 8/9/2010 4:35:39 PM

Test Laboratory: RIM Testing Services

TMFS_T_Coil_Validation_08_09_10_Radial_T

DUT: TMFS; Type: Sample

Communication System: CW; Frequency: 835 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

TMFS Validation Scan with 1kHz/500mVRMS signal level/W y (transversal) 50 x 50 step 4/ABM Signal(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: 1 kHz Sine

Output Gain: 35.05

Measure Window Start: 300ms

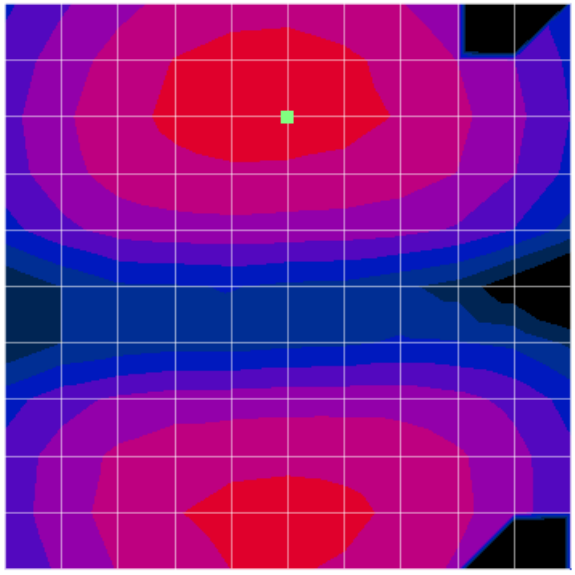
Measure Window Length: 4000ms

BWC applied: -0.0108033 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1 comp = -25.1 dB A/m
BWC Factor = -0.0108033 dB
Location: 0, -15, 3 mm



0 dB = 1.00A/m

Annex C: Audio Band Magnetic measurement data and plots

Date/Time: 8/10/2010 2:07:28 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM850_axial

DUT: BlackBerry Smartphone

Communication System: GSM 850; Frequency: 824.2 MHzFrequency: 836.8 MHzFrequency: 848.8 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.152993 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 34.6 dB
ABM1 comp = 7.16 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -12, 3.7 mm

General Scans Low Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 33.2 dB
ABM1 comp = 5.97 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -10, 3.7 mm

General Scans Mid Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

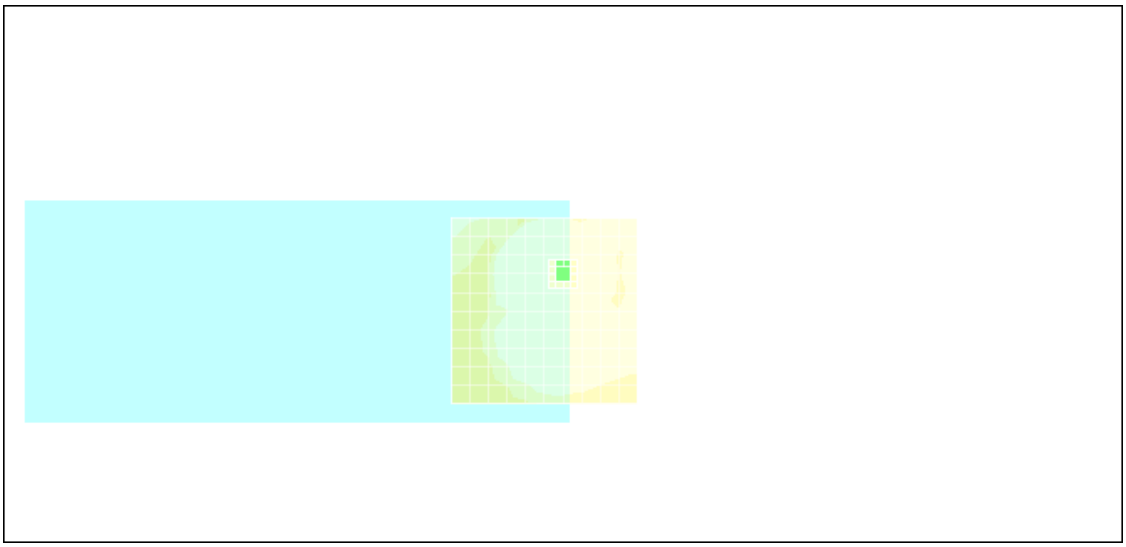
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

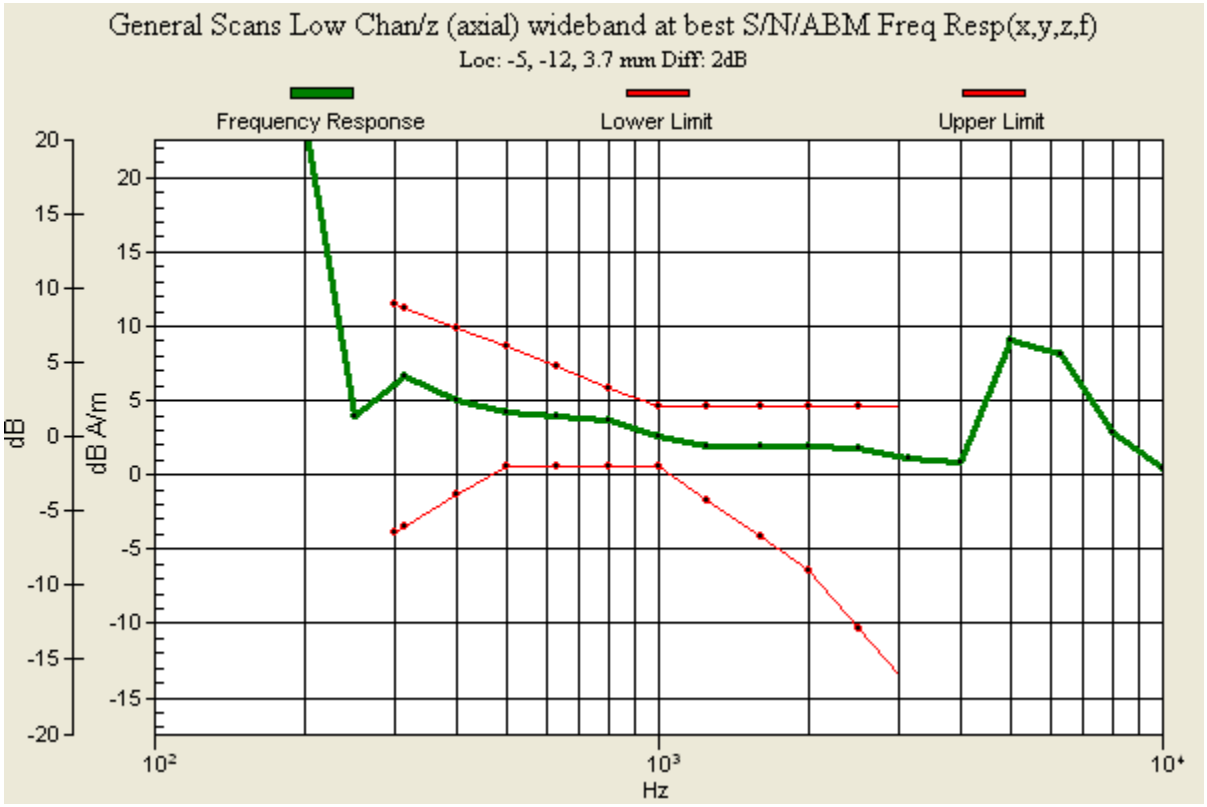
ABM1/ABM2 = 32.8 dB
ABM1 comp = 6.12 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -10, 3.7 mm

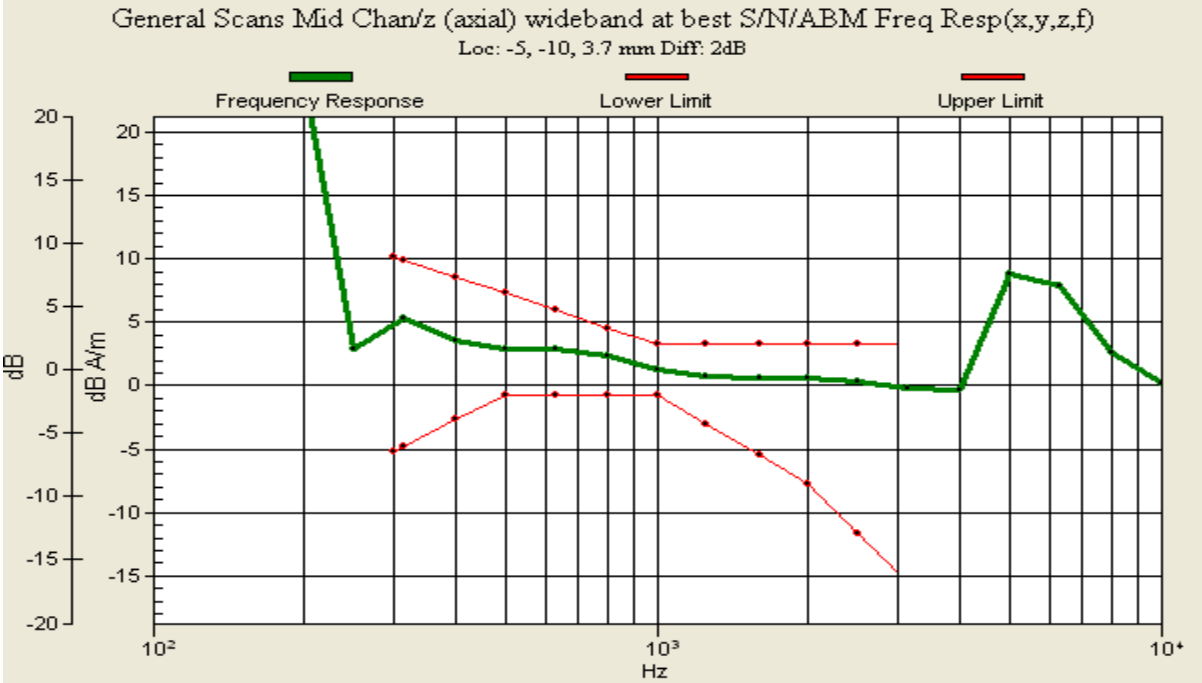
General Scans High Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

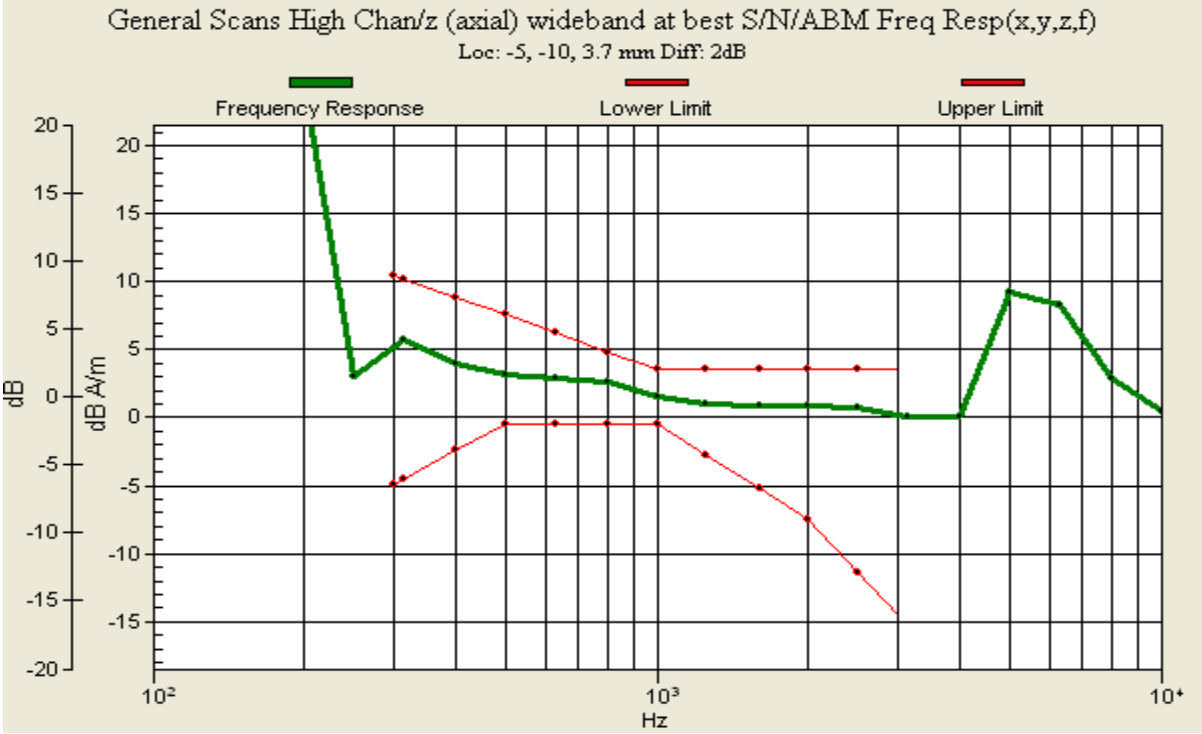
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00







Date/Time: 8/10/2010 2:19:27 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM850_radial L

DUT: BlackBerry Smartphone

Communication System: GSM 850; Frequency: 824.2 MHzFrequency: 836.8 MHzFrequency: 848.8 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.152993 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 24.6 dB
ABM1 comp = -7.14 dB A/m
BWC Factor = 0.152993 dB
Location: -13, -8, 3.7 mm

General Scans Mid Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

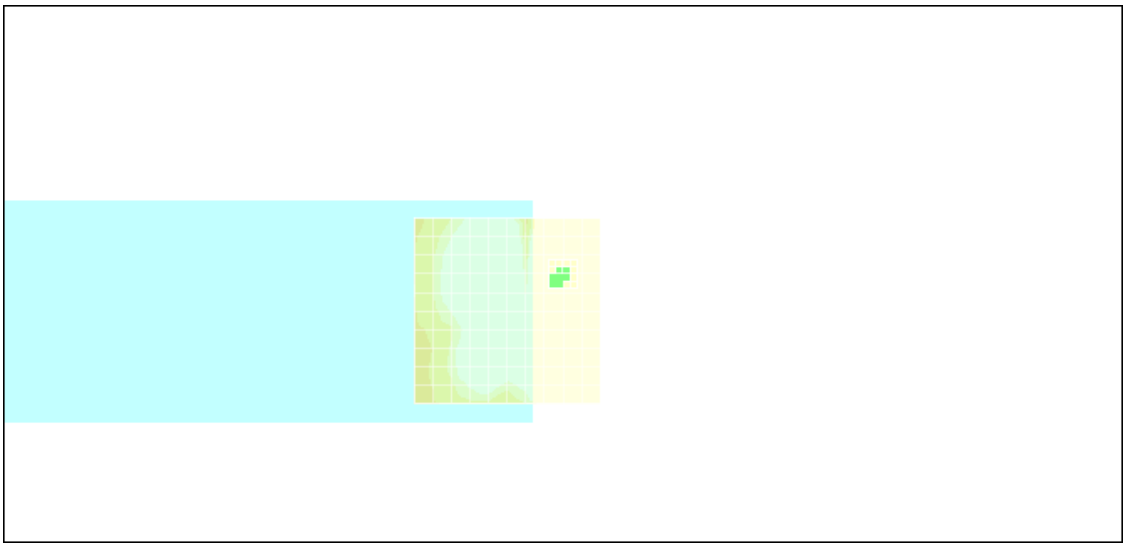
ABM1/ABM2 = 26.2 dB
ABM1 comp = -5.74 dB A/m
BWC Factor = 0.152993 dB
Location: -13, -8, 3.7 mm

General Scans High Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 25.9 dB
ABM1 comp = -5.52 dB A/m
BWC Factor = 0.152993 dB
Location: -13, -8, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 2:29:37 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM850_radial T

DUT: BlackBerry Smartphone

Communication System: GSM 850; Frequency: 824.2 MHzFrequency: 836.8 MHzFrequency: 848.8 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.152993 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 27.1 dB
ABM1 comp = 0.692 dB A/m
BWC Factor = 0.152993 dB
Location: -3, -2, 3.7 mm

General Scans Mid Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

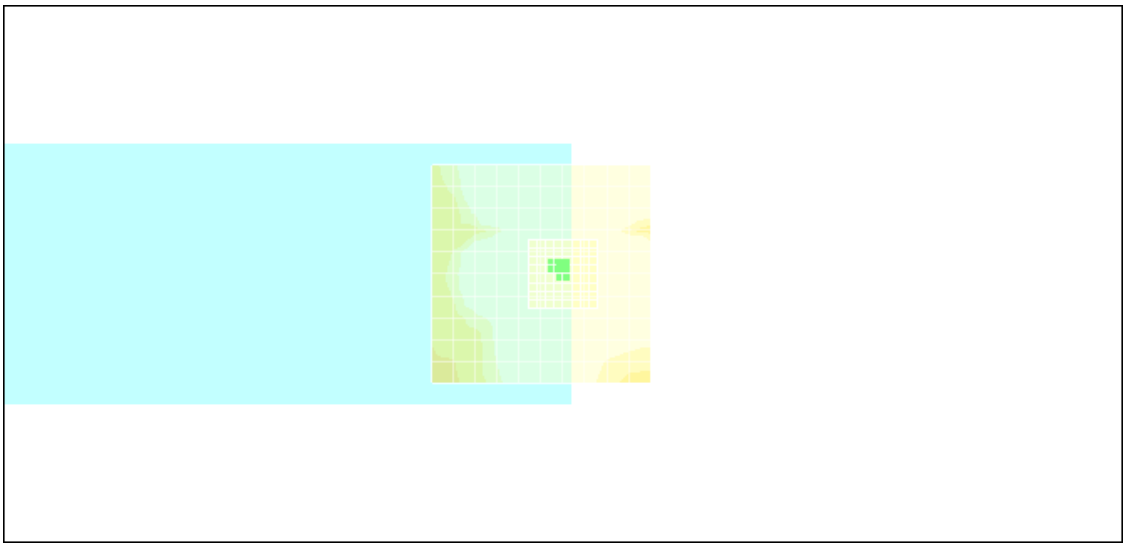
ABM1/ABM2 = 26.1 dB
ABM1 comp = -0.458 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -2, 3.7 mm

General Scans High Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 25.3 dB
ABM1 comp = -0.590 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -2, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 10:00:02 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_axial_low_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

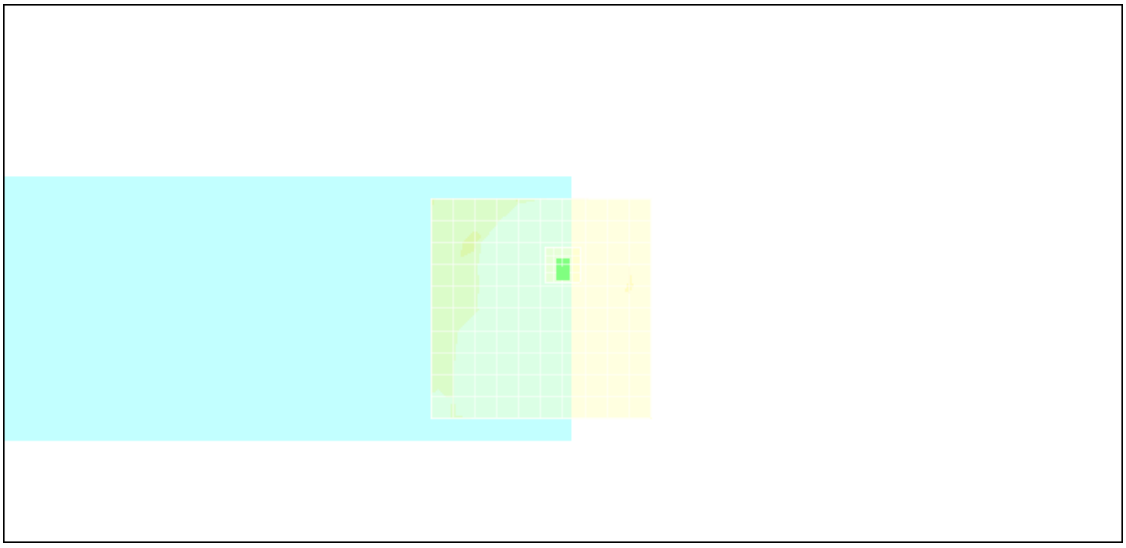
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

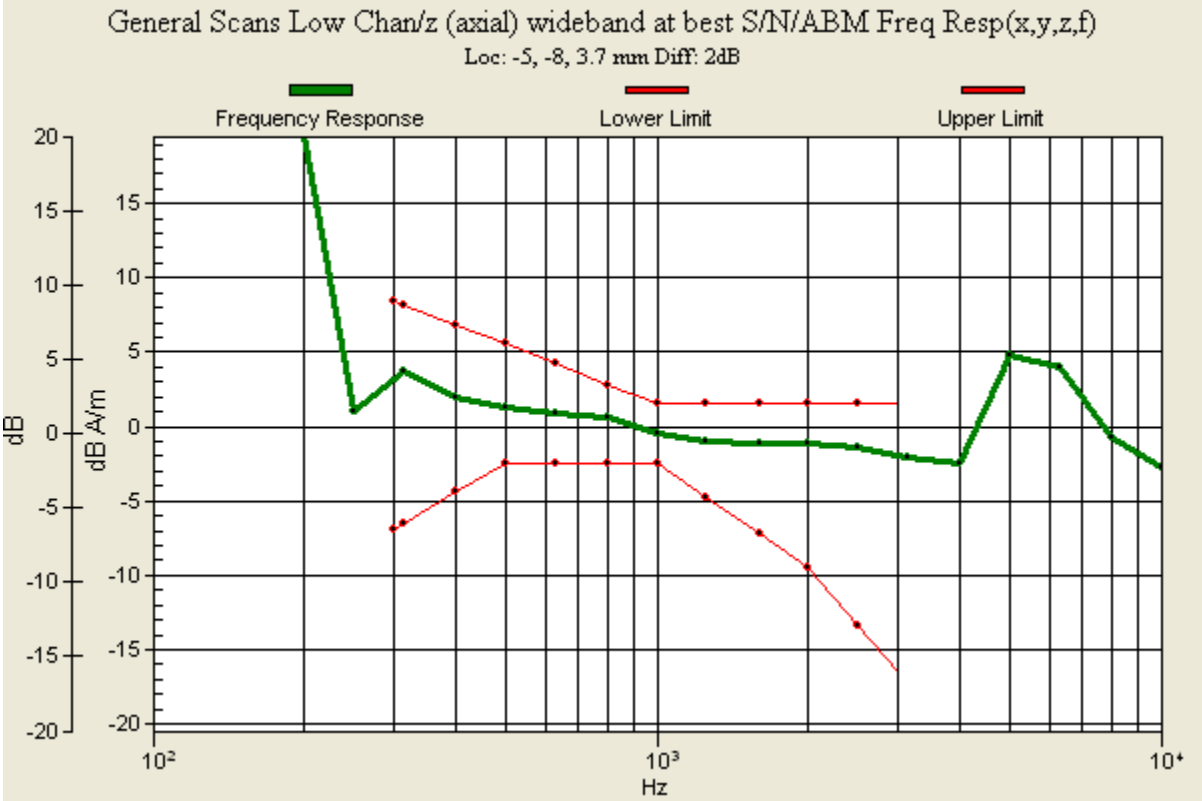
ABM1/ABM2 = 36.0 dB
ABM1 comp = 4.13 dB A/m
BWC Factor = 0.151969 dB
Location: -5, -8, 3.7 mm

General Scans Low Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00



Date/Time: 8/10/2010 10:00:02 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_axial_mid_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHzFrequency: 1880 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

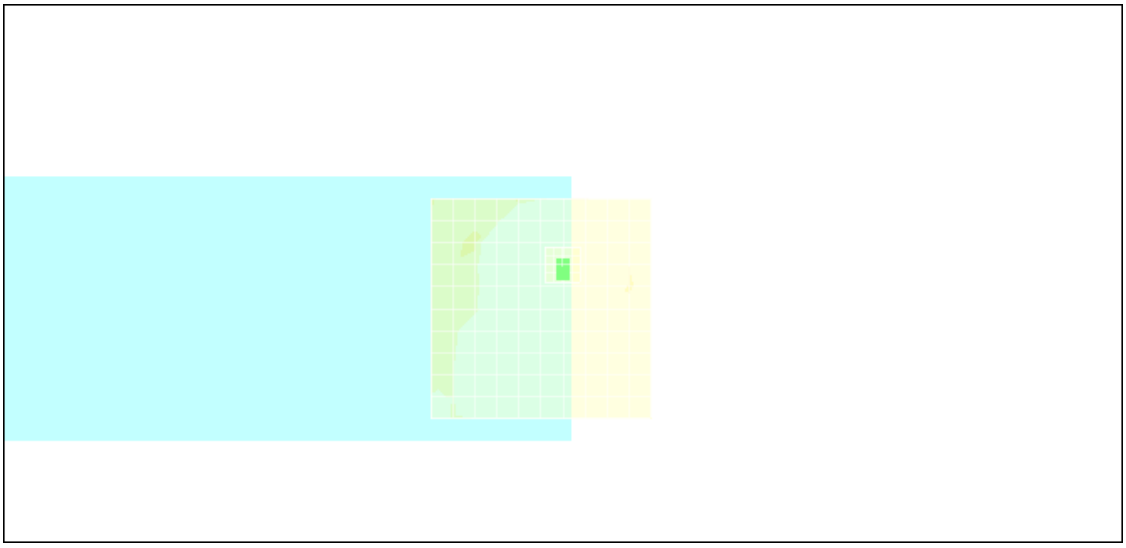
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

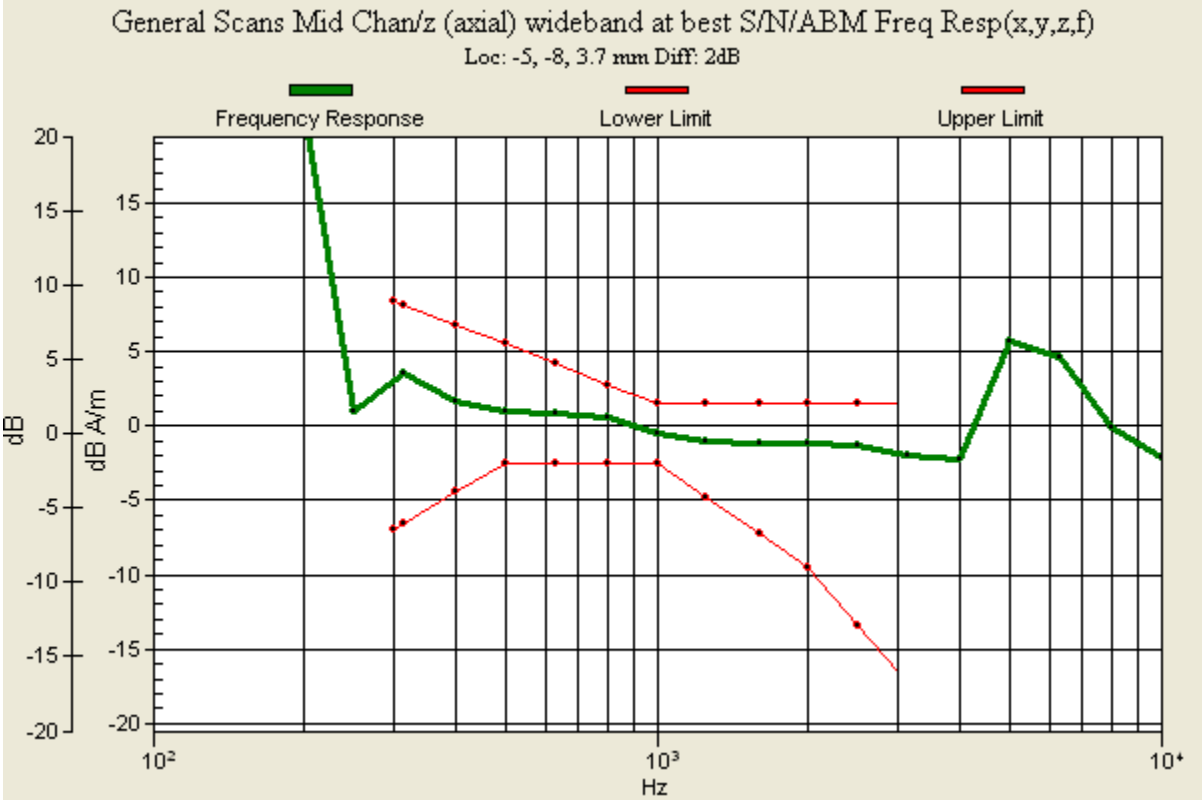
ABM1/ABM2 = 34.5 dB
ABM1 comp = 4.11 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -8, 3.7 mm

General Scans Mid Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00



Date/Time: 8/10/2010 10:00:02 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_axial_high_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHzFrequency: 1909.8 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

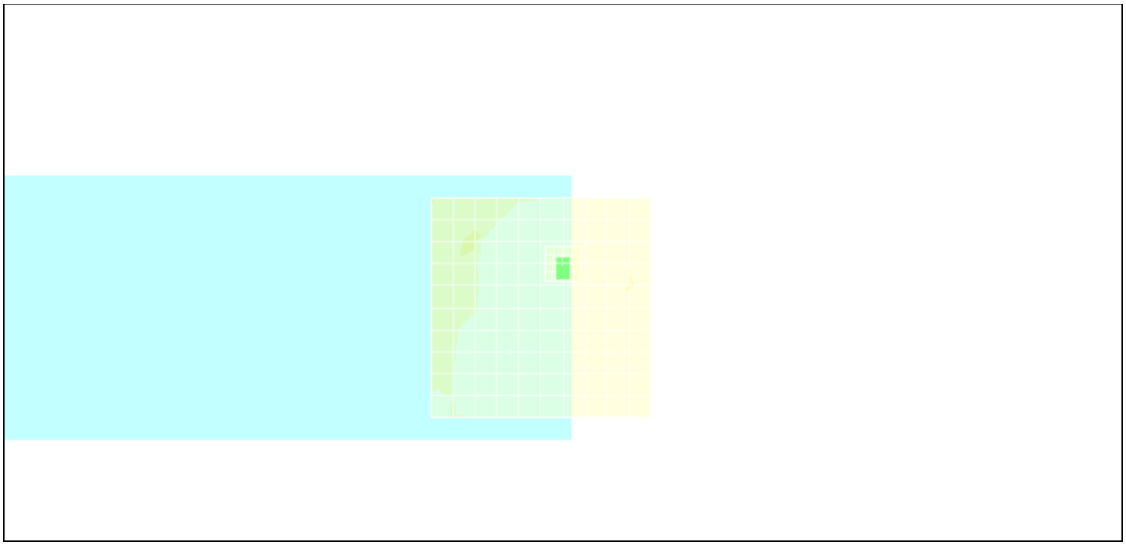
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

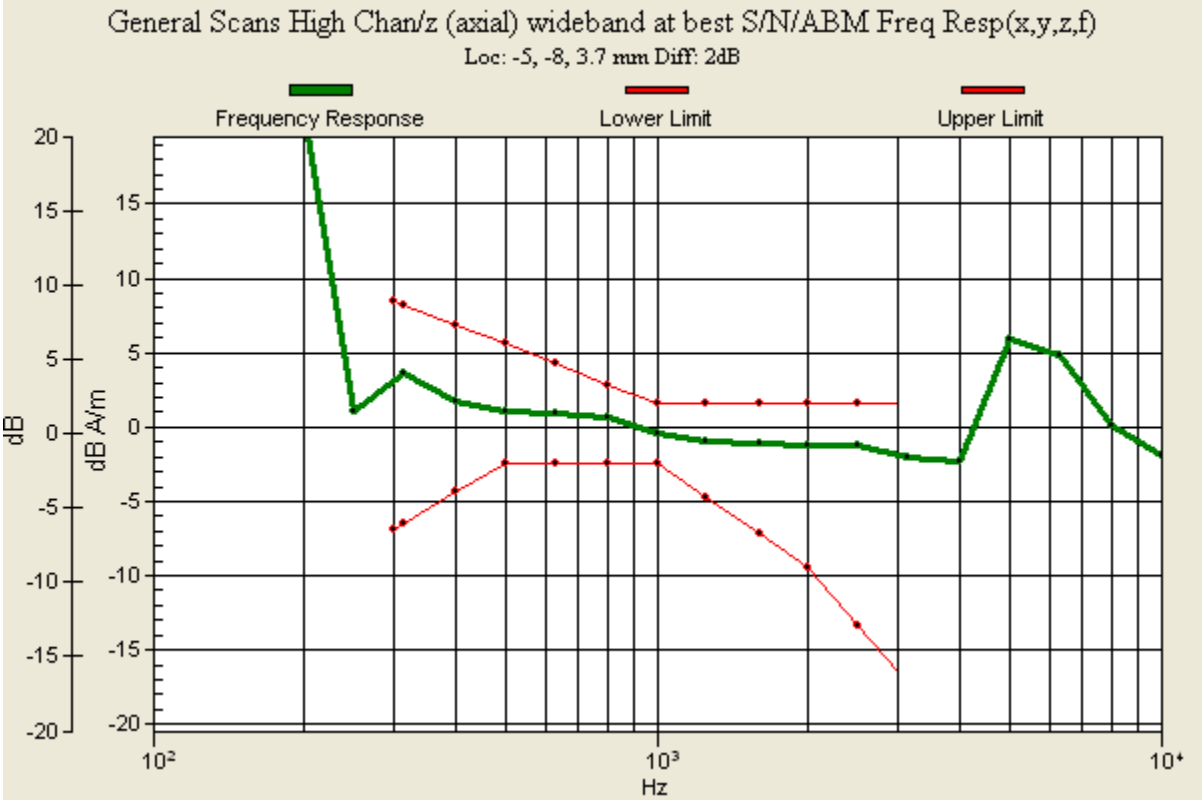
ABM1/ABM2 = 34.0 dB
ABM1 comp = 4.01 dB A/m
BWC Factor = 0.151969 dB
Location: -5, -8, 3.7 mm

General Scans High Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00



Date/Time: 8/10/2010 10:21:39 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_radial L_low_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

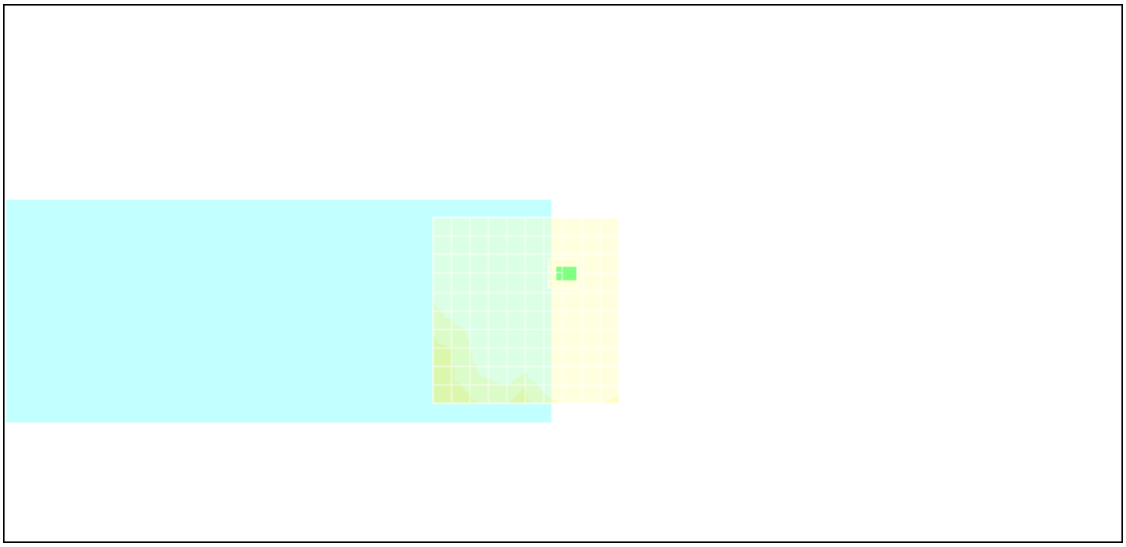
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 39.6 dB
ABM1 comp = -4.04 dB A/m
BWC Factor = 0.151969 dB
Location: -12, -10, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 10:21:39 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_radial L_mid_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHzFrequency: 1880 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

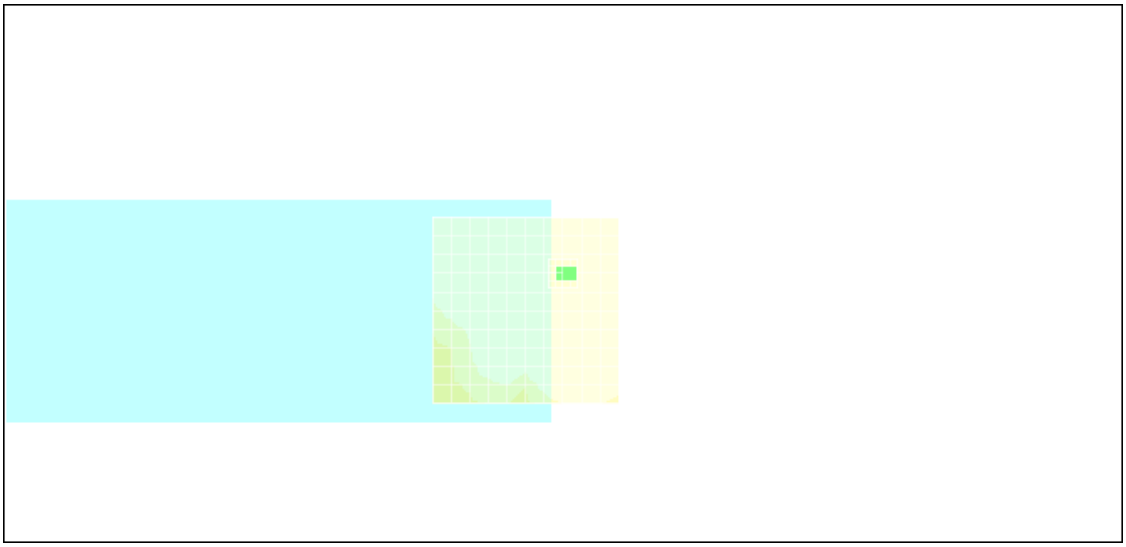
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 38.4 dB
ABM1 comp = -4.08 dB A/m
BWC Factor = 0.152993 dB
Location: -12, -10, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 10:21:39 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_radial L_high_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHzFrequency: 1909.8 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

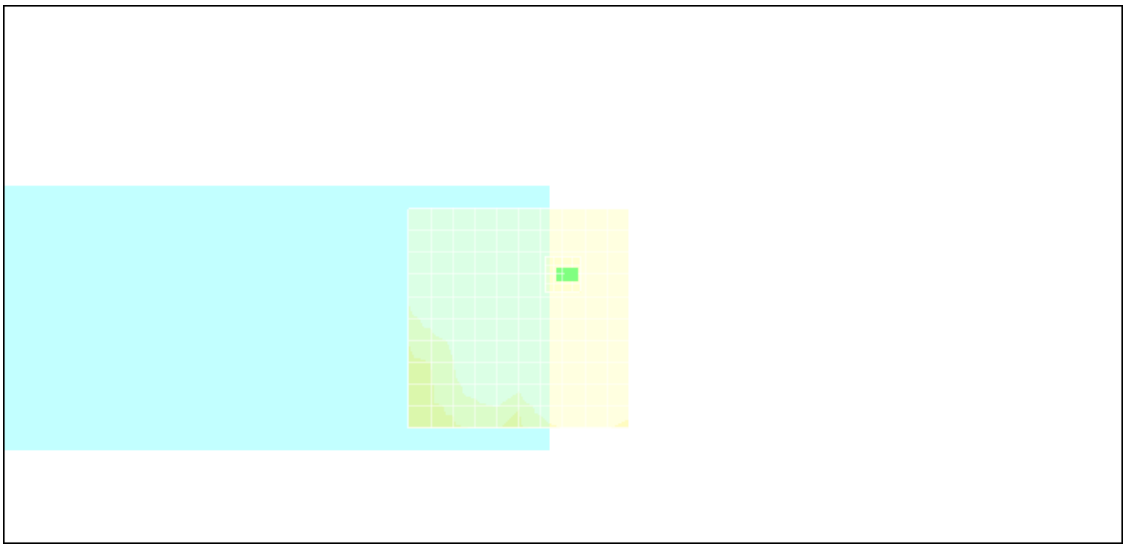
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 38.0 dB
ABM1 comp = -4.08 dB A/m
BWC Factor = 0.151969 dB
Location: -12, -10, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 10:31:48 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_radial T_low_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

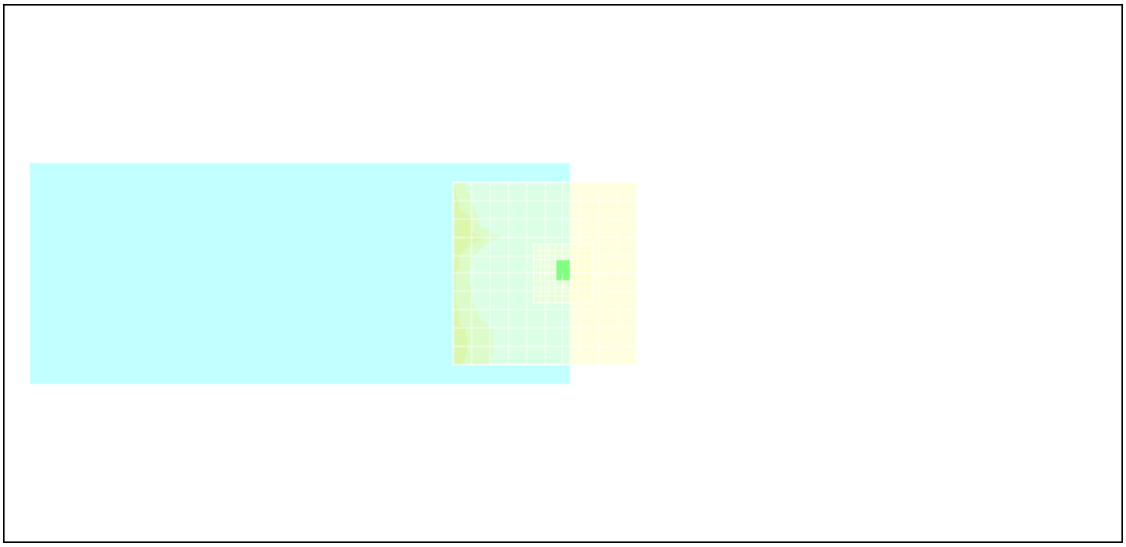
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 31.1 dB
ABM1 comp = -0.982 dB A/m
BWC Factor = 0.151969 dB
Location: -5, -2, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 10:31:48 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_radial T_mid_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHzFrequency: 1880 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

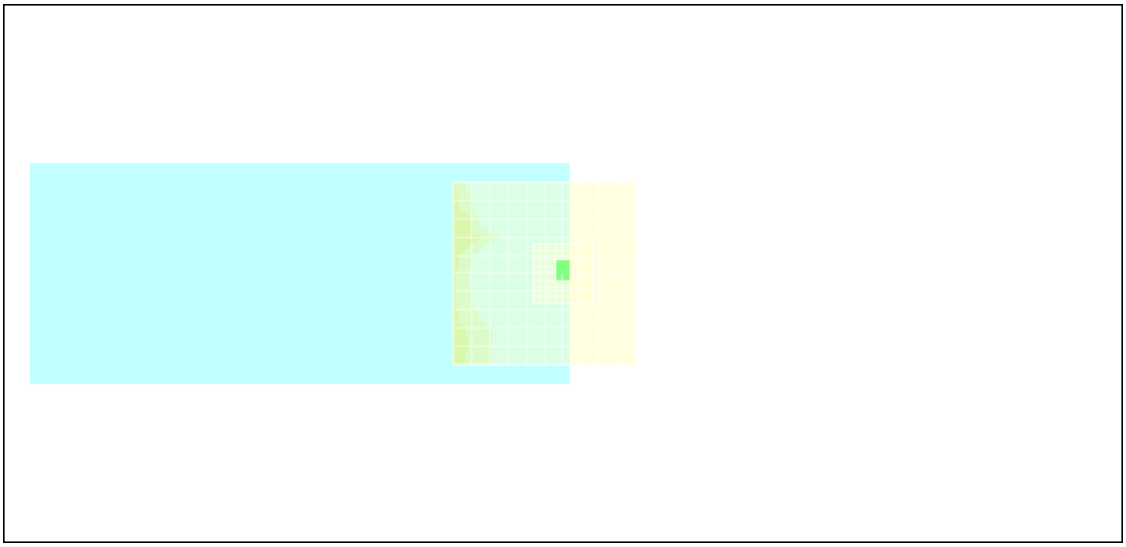
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.152993 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 29.6 dB
ABM1 comp = -1.05 dB A/m
BWC Factor = 0.152993 dB
Location: -5, -2, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 10:31:48 AM

Test Laboratory: RIM Testing Services

HAC_TCoil_GSM1900_radial T_high_chan

DUT: BlackBerry Smartphone

Communication System: GSM 1900; Frequency: 1850.2 MHzFrequency: 1909.8 MHz;Duty Cycle: 1:8.3

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

Measurement Standard: DASY4 (High Precision Assessment)

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

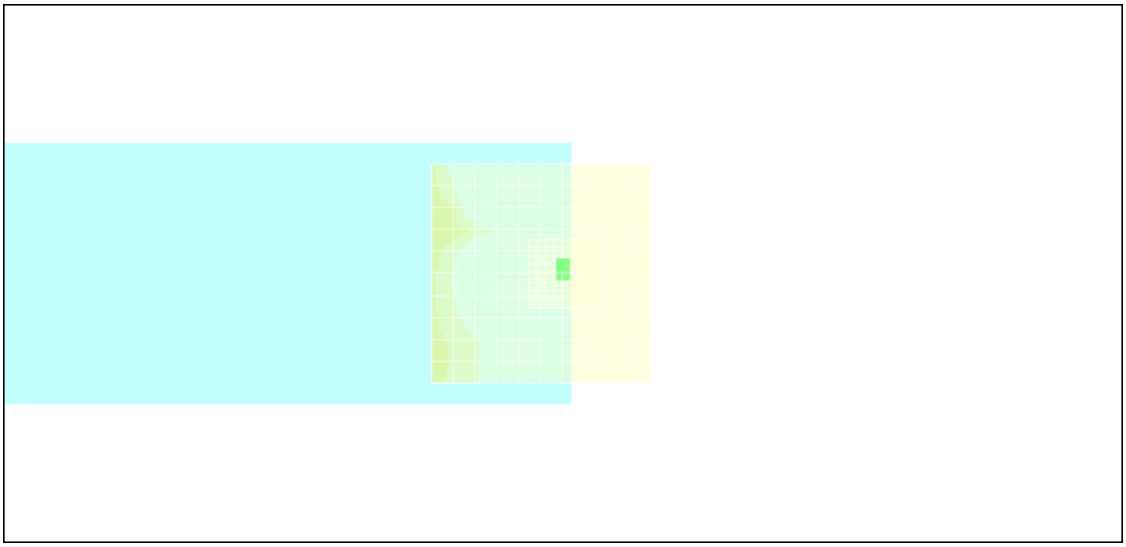
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 29.2 dB
ABM1 comp = -1.05 dB A/m
BWC Factor = 0.151969 dB
Location: -5, -2, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 4:20:45 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_low_chan_Axial

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

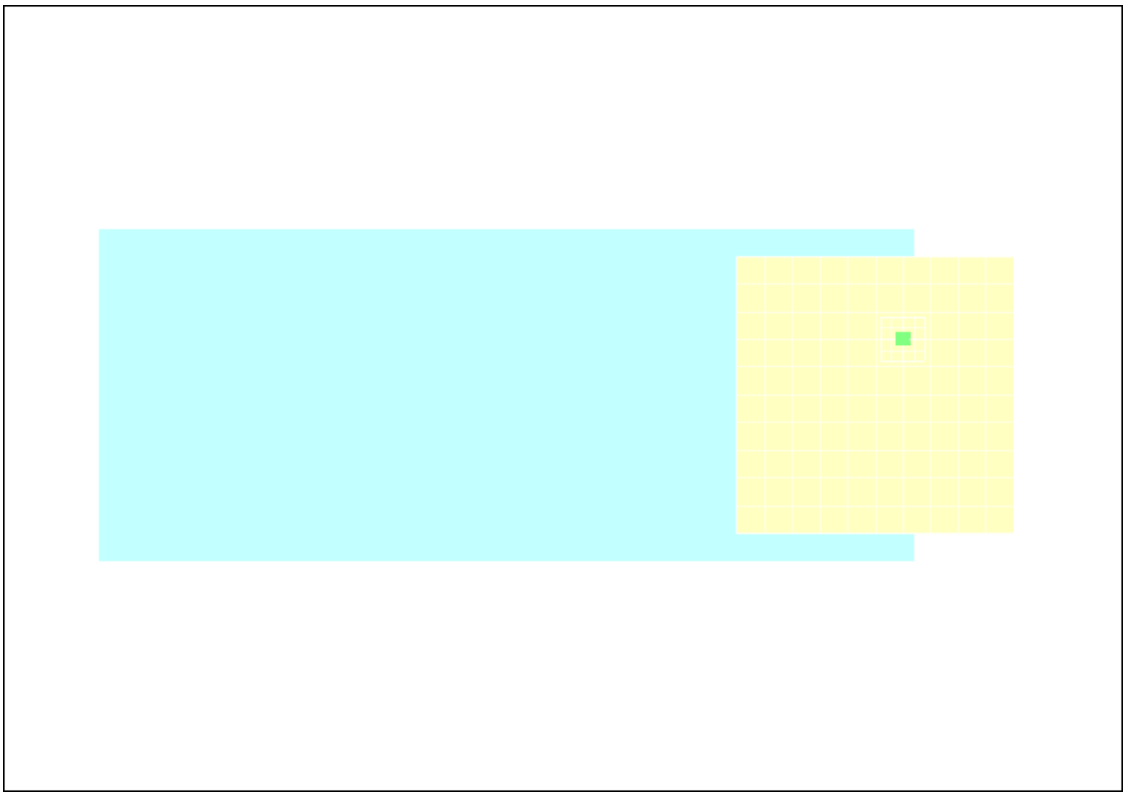
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

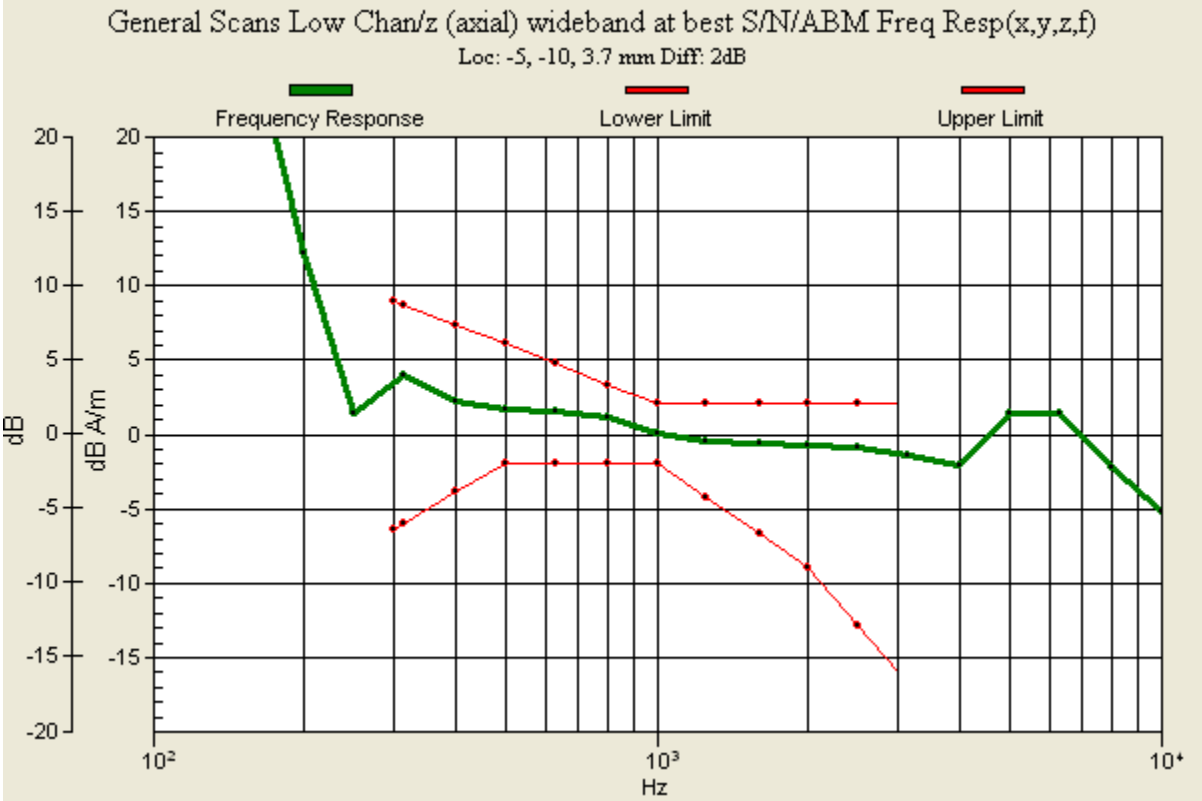
ABM1/ABM2 = 53.1 dB
ABM1 comp = 4.60 dB A/m
BWC Factor = 0.151969 dB
Location: -5, -10, 3.7 mm

General Scans Low Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00



Date/Time: 8/10/2010 4:20:45 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ mid_chan_Axial

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHzFrequency: 1880 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

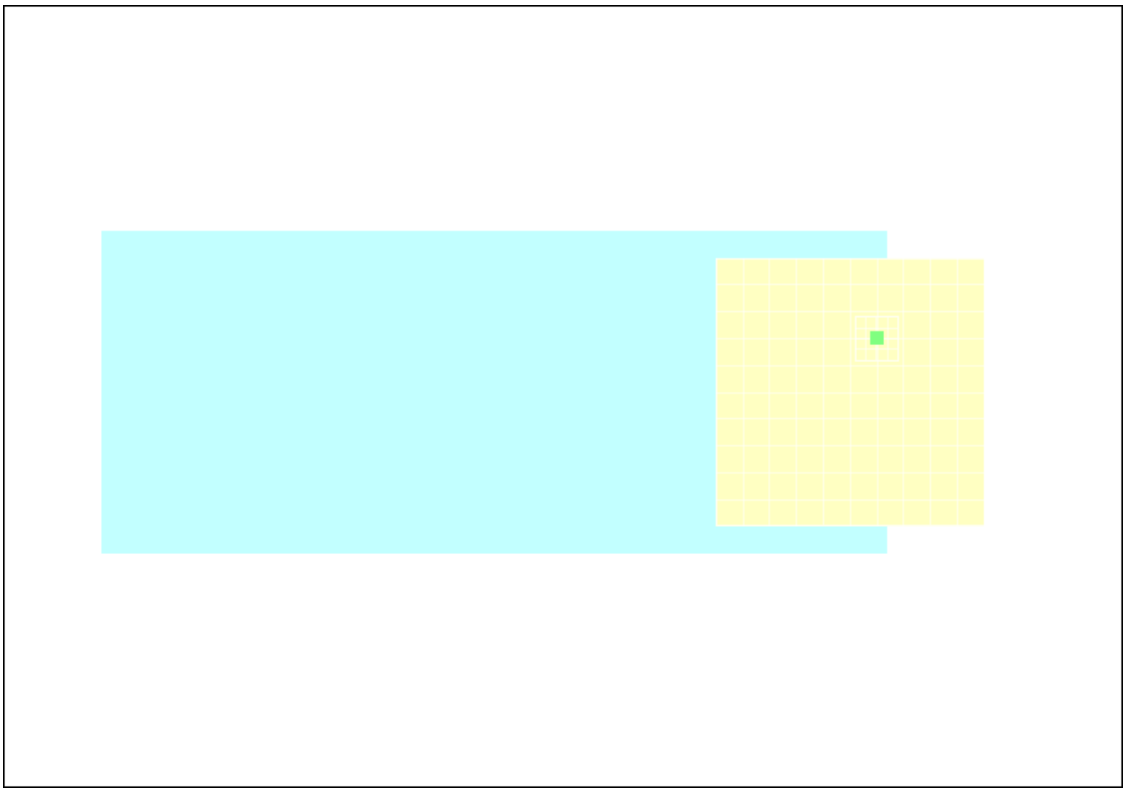
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.15103 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

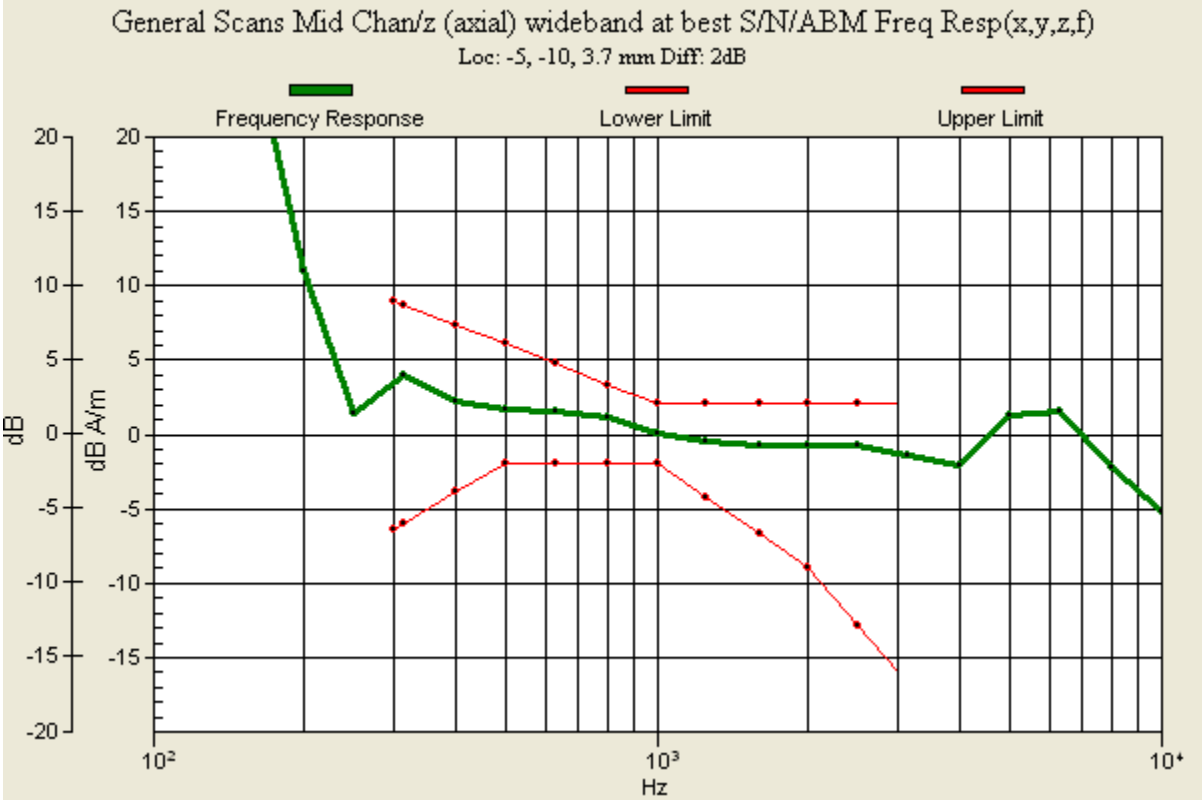
ABM1/ABM2 = 53.0 dB
ABM1 comp = 4.55 dB A/m
BWC Factor = 0.15103 dB
Location: -5, -10, 3.7 mm

General Scans Mid Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00



Date/Time: 8/10/2010 4:20:45 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ high_chan_Axial

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHzFrequency: 1907.6 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/z (axial) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/z (axial) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

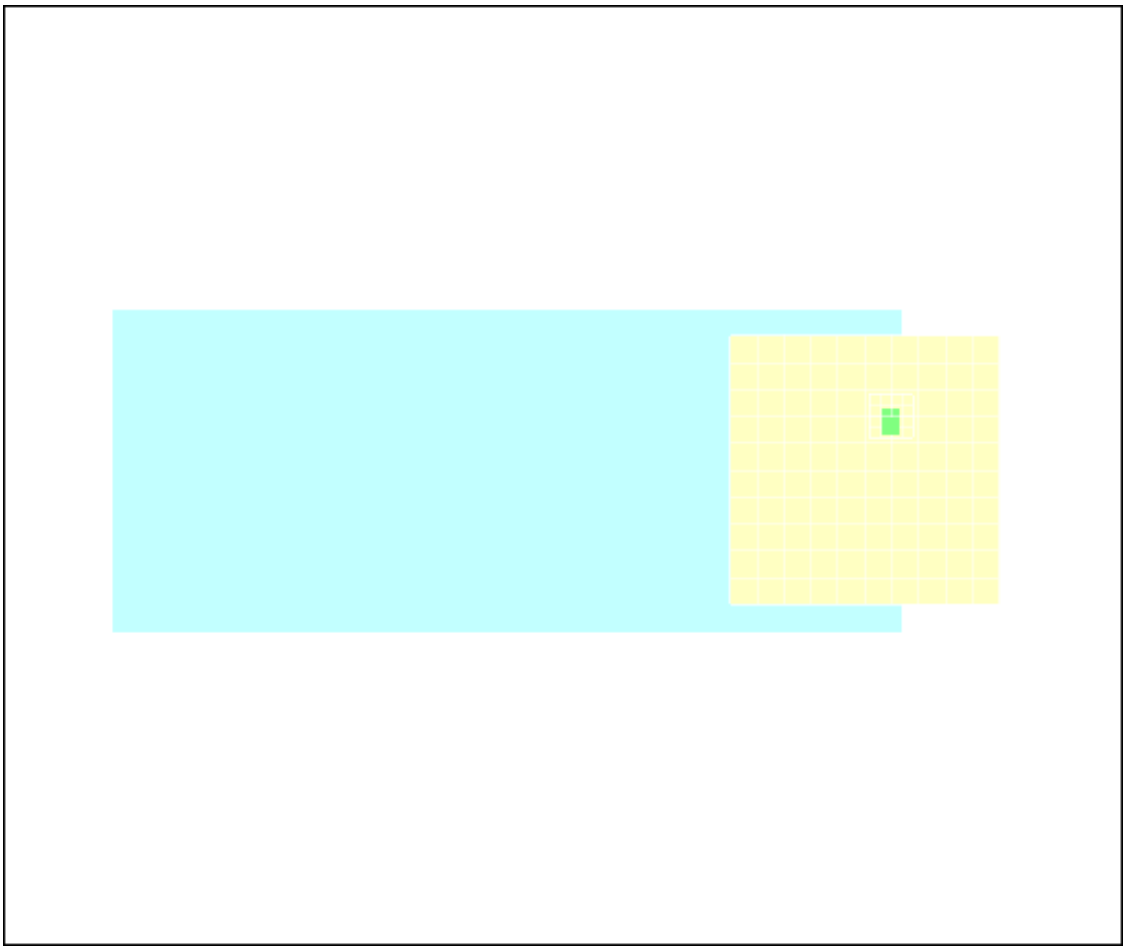
Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.154017 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

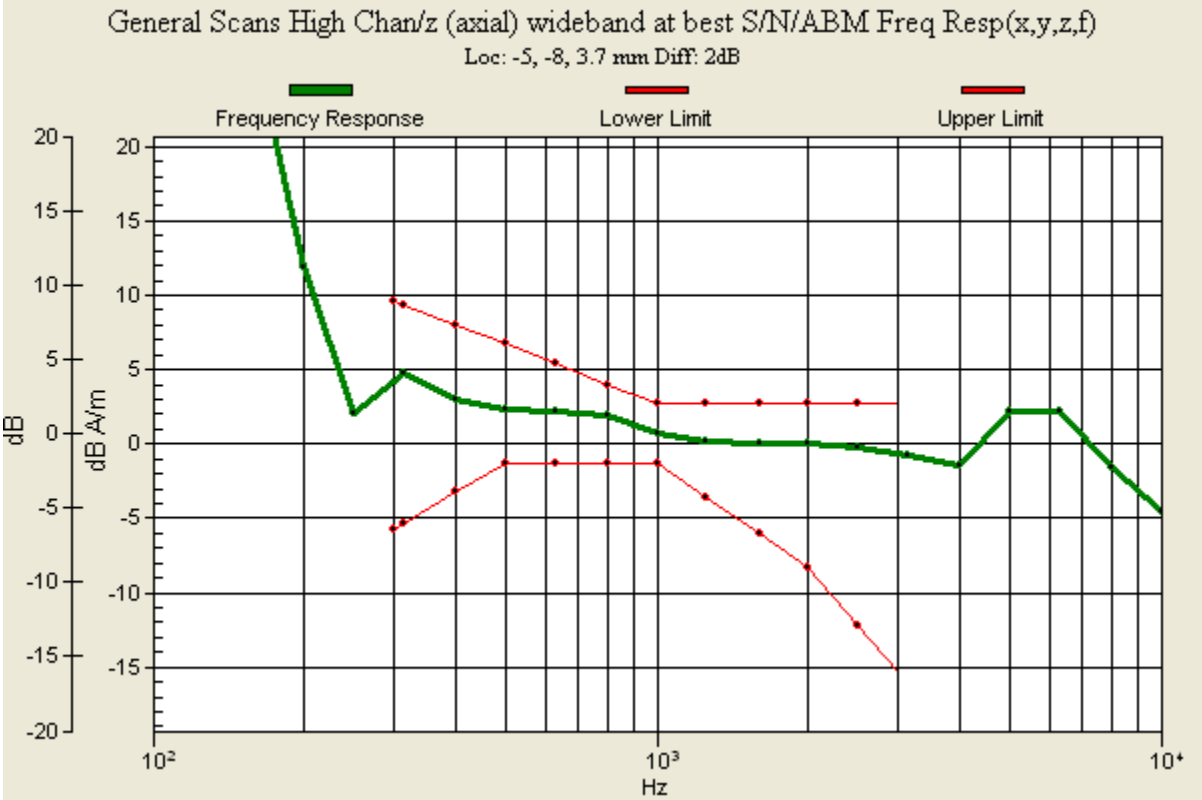
ABM1/ABM2 = 53.1 dB
ABM1 comp = 5.23 dB A/m
BWC Factor = 0.154017 dB
Location: -5, -8, 3.7 mm

General Scans High Chan/z (axial) wideband at best S/N/ABM Freq Resp(x,y,z,f) (1x1x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_300-3000_2s.wav
Output Gain: 69.2
Measure Window Start: 2000ms
Measure Window Length: 4000ms
BWC applied: 10.8 dB
Device Reference Point: 0.000, 0.000, -6.30 mm



0 dB = 1.00



Date/Time: 8/10/2010 4:31:16 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ low_chan_Radial_L

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

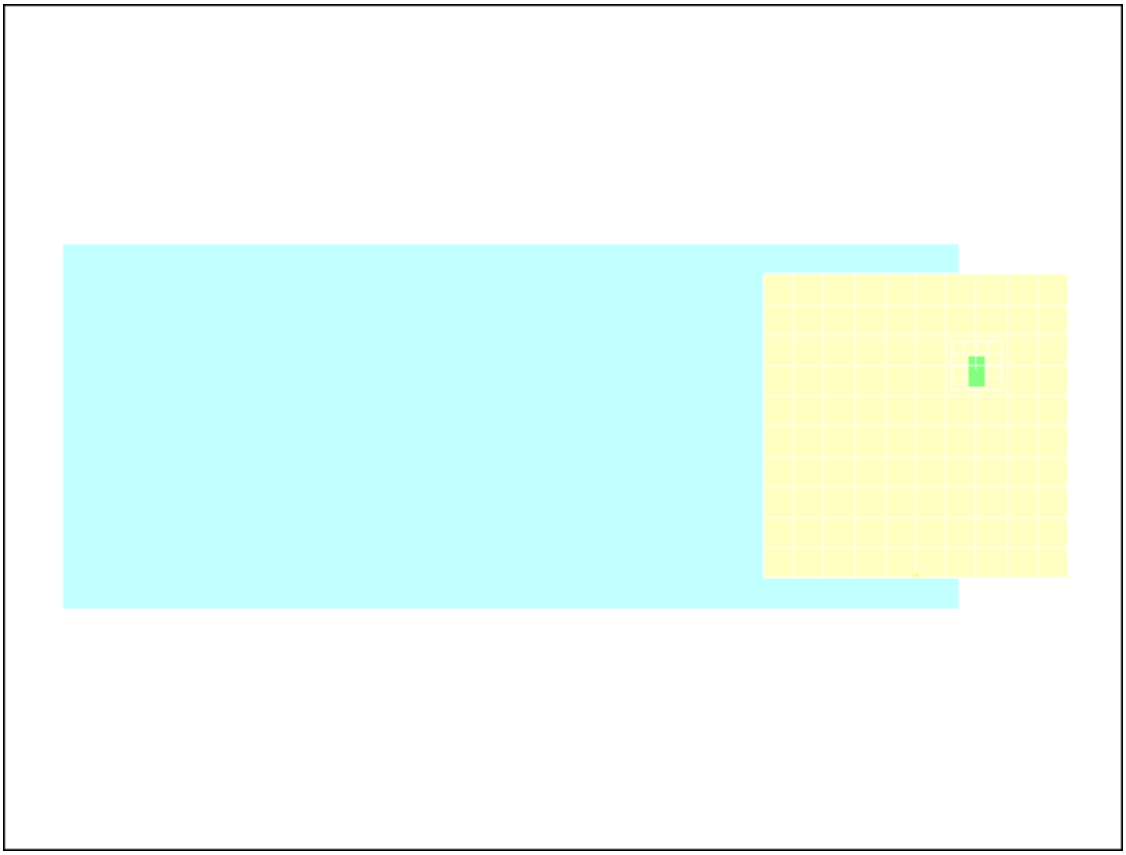
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 47.0 dB
ABM1 comp = -3.73 dB A/m
BWC Factor = 0.151969 dB
Location: -10, -8, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 4:31:16 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ mid_chan_Radial_L

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHzFrequency: 1880 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

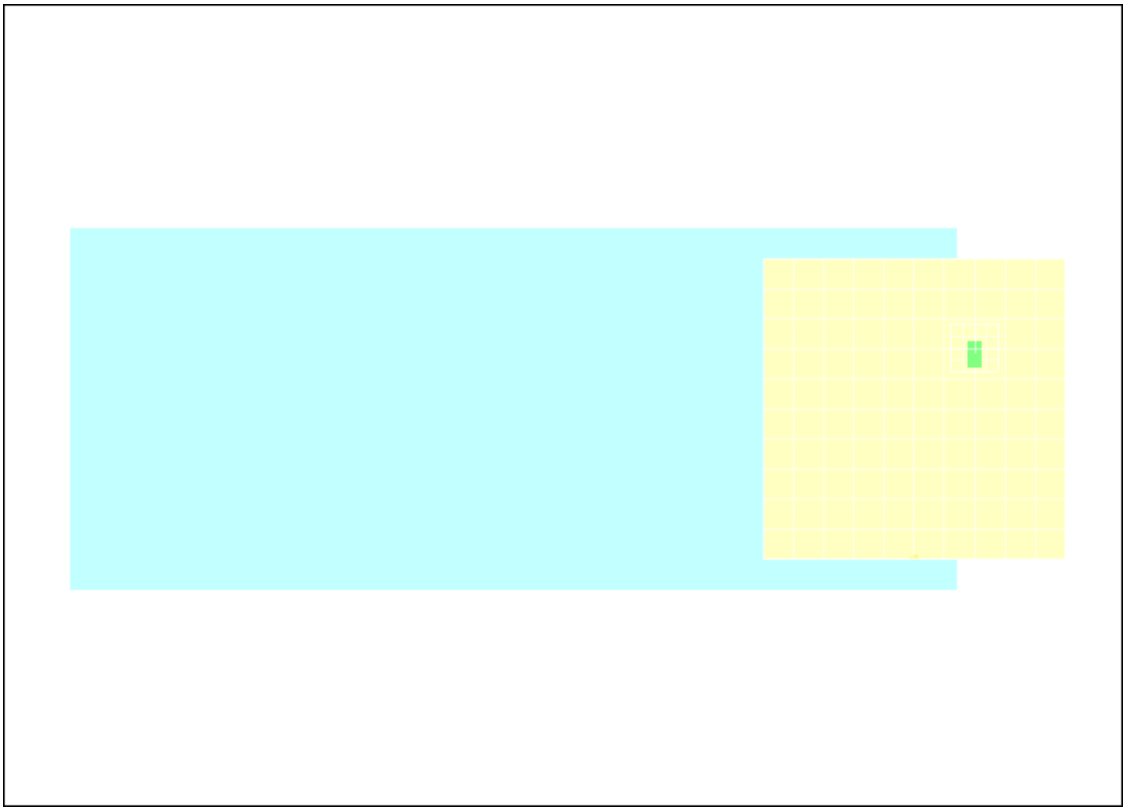
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.15103 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 47.0 dB
ABM1 comp = -3.76 dB A/m
BWC Factor = 0.15103 dB
Location: -10, -8, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 4:31:16 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ high_chan_Radial_L

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHzFrequency: 1907.6 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/x (longitudinal) 5.0mm 50 x 50/ABM SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

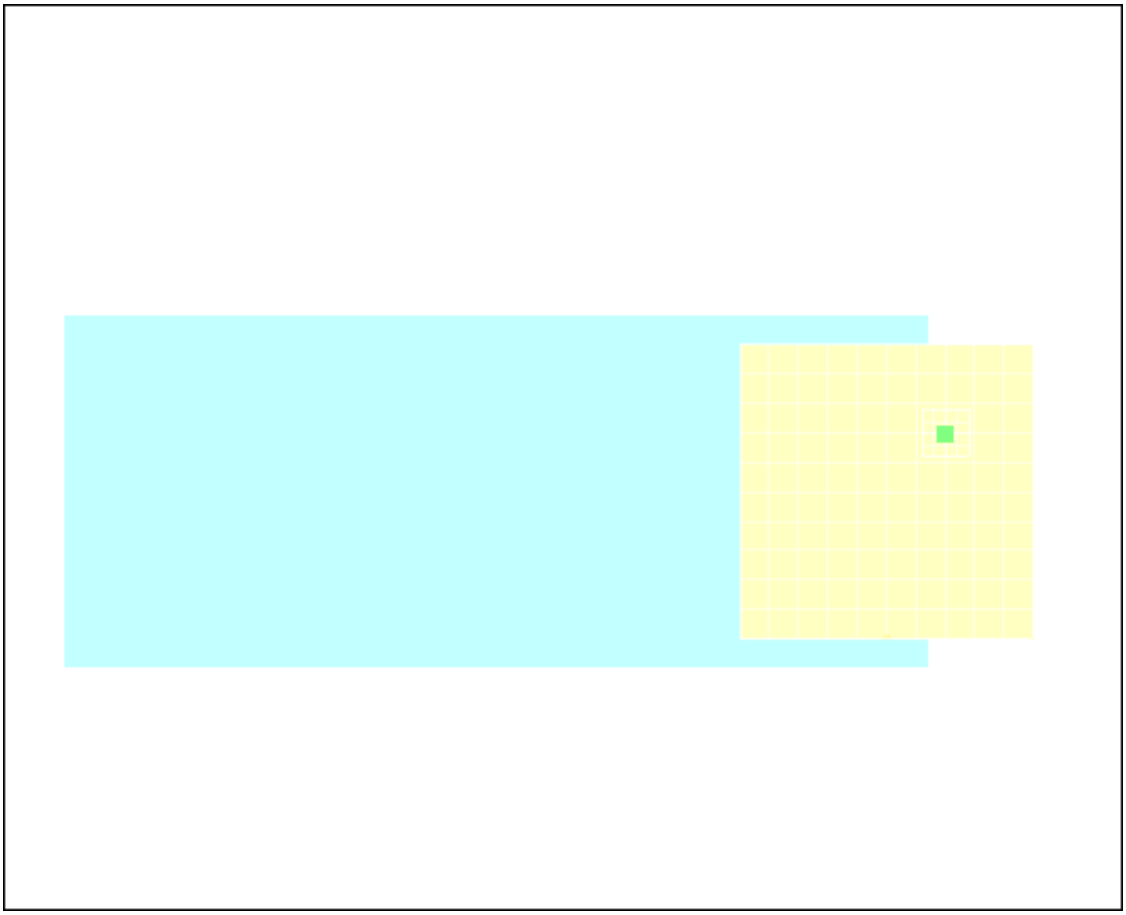
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/x (longitudinal) fine 2mm 8 x 8/ABM SNR(x,y,z) (5x5x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.154017 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 47.4 dB
ABM1 comp = -3.21 dB A/m
BWC Factor = 0.154017 dB
Location: -10, -10, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 4:41:26 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ low_chan_Radial_T

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

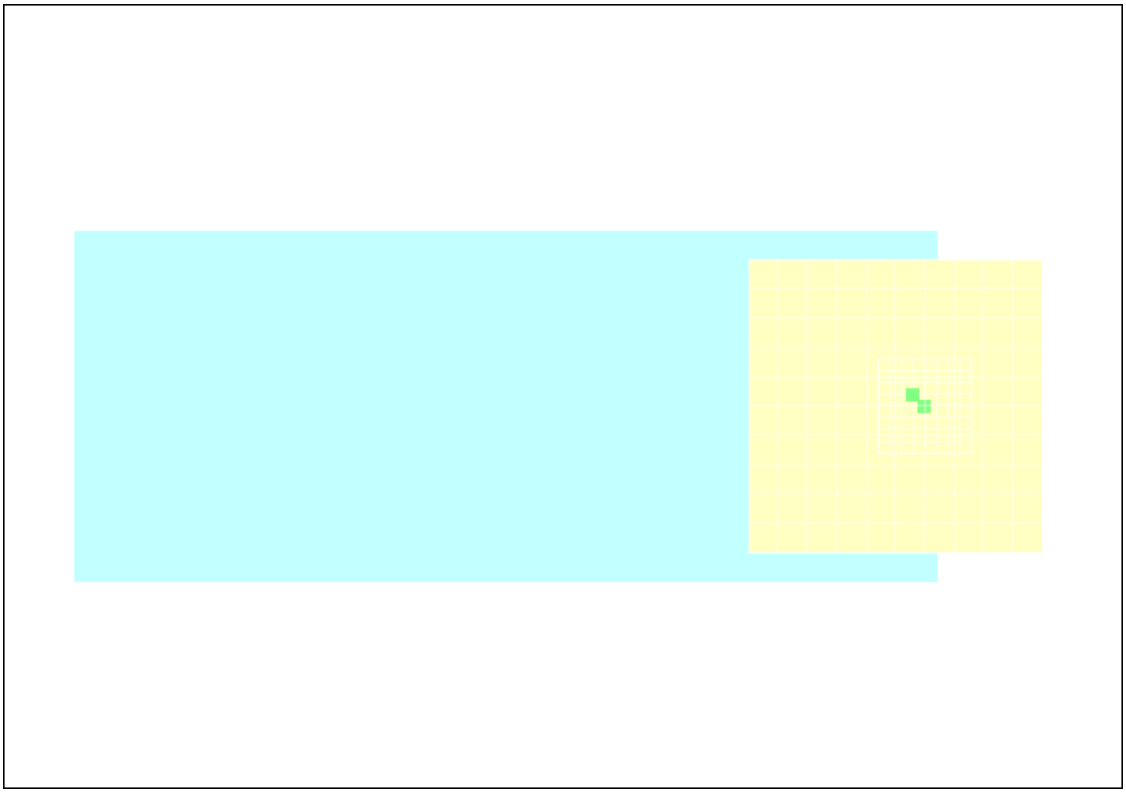
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Low Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.151969 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 48.0 dB
ABM1 comp = 0.084 dB A/m
BWC Factor = 0.151969 dB
Location: -3, -2, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 4:41:26 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ mid_chan_Radial_T

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHzFrequency: 1880 MHz;Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\varepsilon_r = 1$; $\rho = 1$ kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

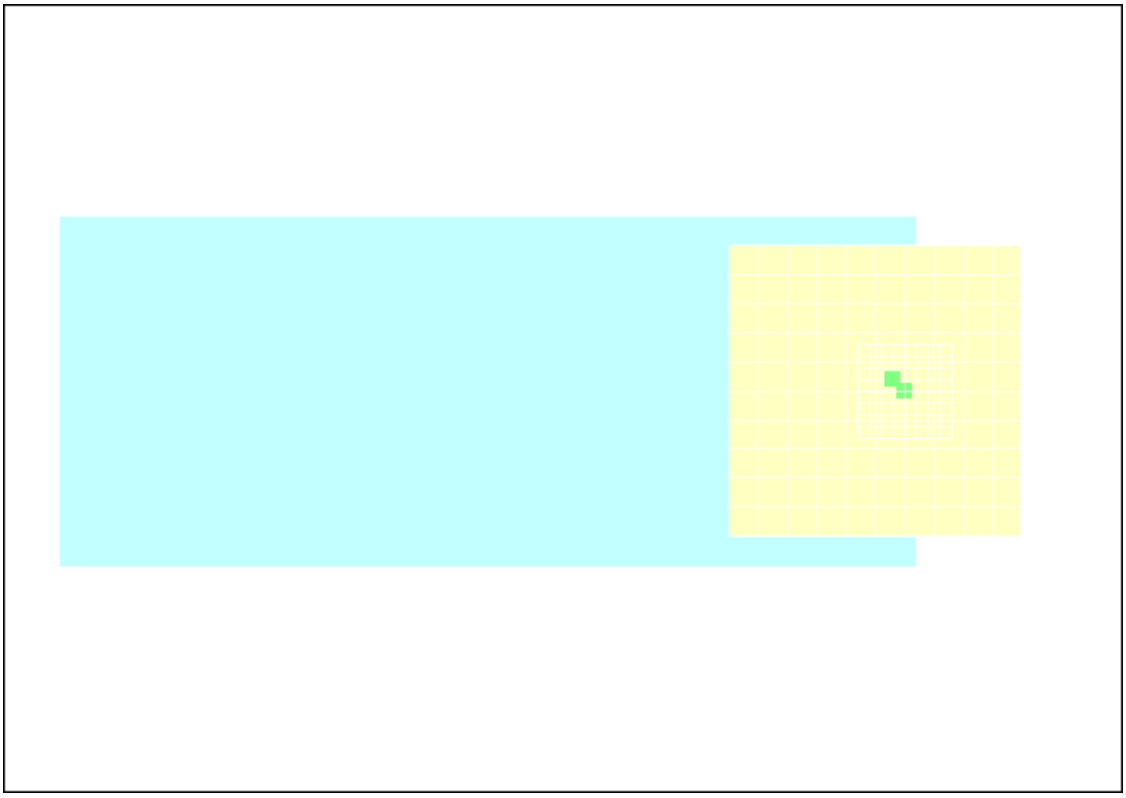
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans Mid Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.15103 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 47.9 dB
ABM1 comp = 0.078 dB A/m
BWC Factor = 0.15103 dB
Location: -3, -2, 3.7 mm



0 dB = 1.00

Date/Time: 8/10/2010 4:41:26 PM

Test Laboratory: RIM Testing Services

HAC_TCoil_UMTS_FDD II_1900_ high_chan_Radial_T

DUT: BlackBerry Smartphone

Communication System: WCDMA FDD II; Frequency: 1852.4 MHzFrequency: 1907.6 MHz;Duty Cycle: 1:1

Medium parameters used: σ = 0 mho/m, ε_r = 1; ρ = 1 kg/m^3

Phantom section: TCoil Section

DASY4 Configuration:

- Probe: AM1DV3 - 3062; ; Calibrated: 6/8/2010
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn473; Calibrated: 1/4/2010
- Phantom: HAC RF Test Arch with AMCC; Type: SD HAC P01 BA;
- Measurement SW: DASY4, V4.7 Build 80; Postprocessing SW: SEMCAD, V1.8 Build 186

General Scans Low Chan/y (transversal) 5.0mm 50 x 50/ABM

SNR(x,y,z) (11x11x1):

Measurement grid: dx=10mm, dy=10mm

Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav

Output Gain: 35.3

Measure Window Start: 300ms

Measure Window Length: 1000ms

BWC applied: 0.151969 dB

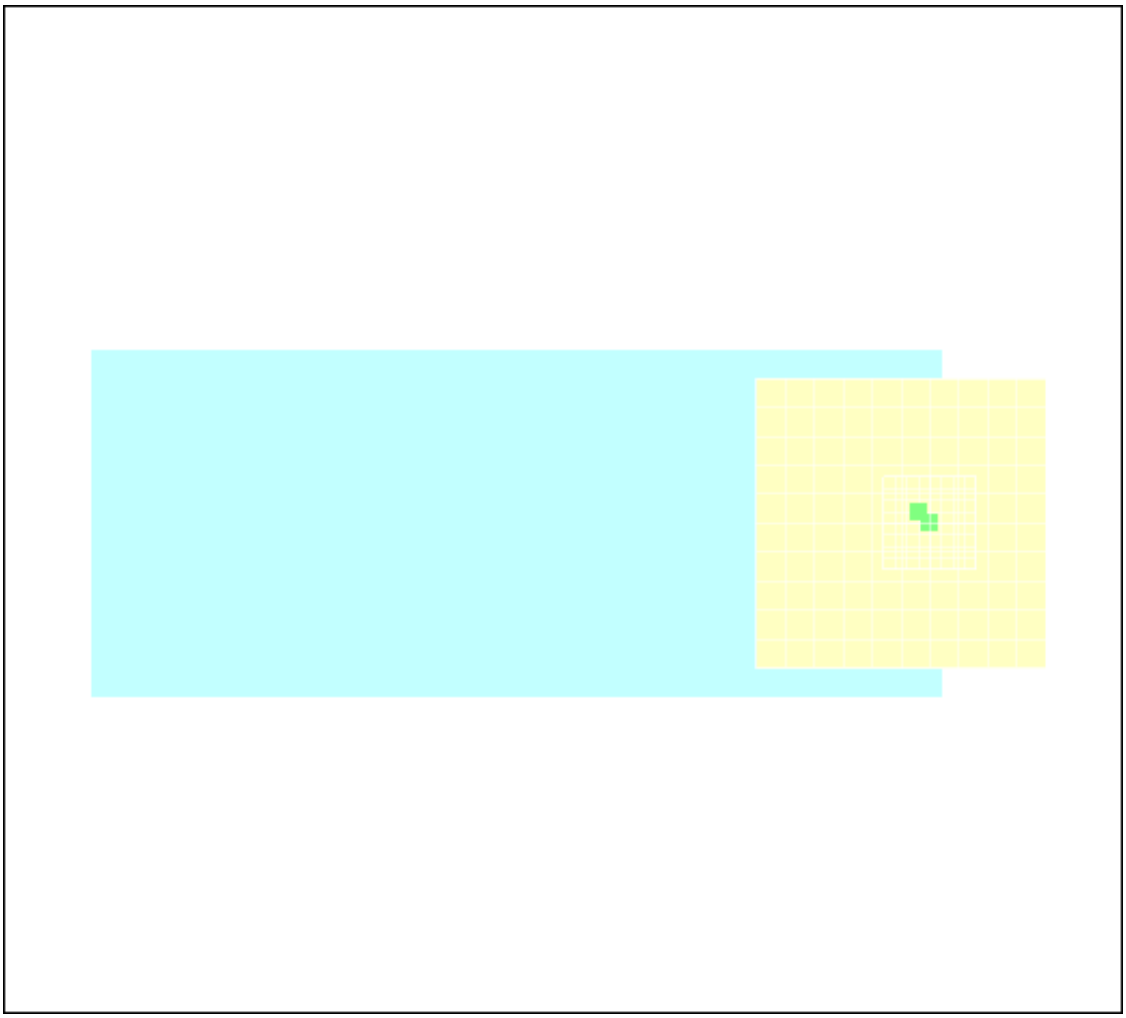
Device Reference Point: 0.000, 0.000, -6.30 mm

General Scans High Chan/y (transversal) fine 2mm 8 x 8/ABM SNR(x,y,z) (9x9x1):

Measurement grid: dx=10mm, dy=10mm
Signal Type: Audio File (.wav) 48k_voice_1kHz_1s.wav
Output Gain: 35.3
Measure Window Start: 300ms
Measure Window Length: 2000ms
BWC applied: 0.154017 dB
Device Reference Point: 0.000, 0.000, -6.30 mm

Cursor:

ABM1/ABM2 = 48.2 dB
ABM1 comp = 0.312 dB A/m
BWC Factor = 0.154017 dB
Location: -3, -2, 3.7 mm



0 dB = 1.00

Annex D: Probe/TMFS calibration certificate and equipment spec

Calibration Laboratory of
Schmid & Partner
Engineering AG
Zeughausstrasse 43, 8004 Zurich, Switzerland

S Schweizerischer Kalibrierdienst
C Service suisse d'étalonnage
S Servizio svizzero di taratura
S Swiss Calibration Service

Accredited by the Swiss Accreditation Service (SAS)
The Swiss Accreditation Service is one of the signatories to the EA Multilateral Agreement for the recognition of calibration certificates

Accreditation No.: SCS 108

Client **RTS (RIM Testing Service)**

Certificate No: AM1DV3-3062_Jun10

CALIBRATION CERTIFICATE

Object	AM1DV3 - SN: 3062
Calibration procedure(s)	QA CAL-24.v2 Calibration procedure for AM1D magnetic field probes and TMFS in the audio range
Calibration date:	June 8, 2010

This calibration certificate documents the traceability to national standards, which realize the physical units of measurements (SI).
The measurements and the uncertainties with confidence probability are given on the following pages and are part of the certificate.

All calibrations have been conducted in the closed laboratory facility: environment temperature (22 ± 3)°C and humidity < 70%.

Calibration Equipment used (M&TE critical for calibration)

Primary Standards	ID #	Cal Date (Certificate No.)	Scheduled Calibration
Keithley Multimeter Type 2001	SN: 0810278	1-Oct-09 (No: 9055)	Oct-10
Reference Probe AM1DV3	SN: 3000	17-Aug-09 (No. AM1D-3000_Aug09)	Aug-10
DAE4	SN: 781	22-Jan-10 (No. DAE4-781_Jan10)	Jan-11

Secondary Standards	ID #	Check Date (in house)	Scheduled Check
AMCC	1050	15-Oct-09 (in house check Oct-09)	Oct-10

	Name	Function	Signature
Calibrated by:	Mike Meili	Laboratory Technician	
Approved by:	Fin Bomholt	R&D Director	

Issued: June 9, 2010

This calibration certificate shall not be reproduced except in full without written approval of the laboratory.

References

[1] ANSI C63.19-2007
American National Standard for Methods of Measurement of Compatibility between Wireless Communications Devices and Hearing Aids.
[2] DASY4 manual, Chapter: Hearing Aid Compatibility (HAC) T-Coil Extension

Description of the AM1D probe

The AM1D Audio Magnetic Field Probe is a fully shielded magnetic field probe for the frequency range from 100 Hz to 20 kHz. The pickup coil is compliant with the dimensional requirements of [1]. The probe includes a symmetric low noise amplifier for the signal available at the shielded 3 pin connector at the side. Power is supplied via the same connector (phantom power supply) and monitored via the LED near the connector. The 7 pin connector at the end of the probe does not carry any signals, but determines the angle of the sensor when mounted on the DAE. The probe supports mechanical detection of the surface.
The single sensor in the probe is arranged in a tilt angle allowing measurement of 3 orthogonal field components when rotating the probe by 120° around its axis. It is aligned with the perpendicular component of the field, if the probe axis is tilted nominally 35.3° above the measurement plane, using the connector rotation and sensor angle stated below.
The probe is fully RF shielded when operated with the matching signal cable (shielded) and allows measurement of audio magnetic fields in the close vicinity of RF emitting wireless devices according to [1] without additional shielding.

Handling of the item

The probe is manufactured from stainless steel. In order to maintain the performance and calibration of the probe, it must not be opened. The probe is designed for operation in air and shall not be exposed to humidity or liquids. For proper operation of the surface detection and emergency stop functions in a DASY system, the probe must be operated with the special probe cup provided (larger diameter).

Methods Applied and Interpretation of Parameters

- *Coordinate System:* The AM1D probe is mounted in the DASY system for operation with a HAC Test Arch phantom with AMCC Helmholtz calibration coil according to [2], with the tip pointing to "southwest" orientation.
- *Functional Test:* The functional test preceding calibration includes test of
  Noise level
  RF immunity (1kHz AM modulated signal). The shield of the probe cable must be well connected.
  Frequency response verification from 100 Hz to 10 kHz.
- *Connector Rotation:* The connector at the end of the probe does not carry any signals and is used for fixation to the DAE only. The probe is operated in the center of the AMCC Helmholtz coil using a 1 kHz magnetic field signal. Its angle is determined from the two minima at nominally +120° and –120° rotation, so the sensor in the tip of the probe is aligned to the vertical plane in z-direction, corresponding to the field maximum in the AMCC Helmholtz calibration coil.
- *Sensor Angle:* The sensor tilting in the vertical plane from the ideal vertical direction is determined from the two minima at nominally +120° and –120°. DASY system uses this angle to align the sensor for radial measurements to the x and y axis in the horizontal plane.
- *Sensitivity:* With the probe sensor aligned to the z-field in the AMCC, the output of the probe is compared to the magnetic field in the AMCC at 1 kHz. The field in the AMCC Helmholtz coil is given by the geometry and the current through the coil, which is monitored on the precision shunt resistor of the coil.

AM1D probe identification and configuration data

Item	**AM1DV3** Audio Magnetic 1D Field Probe
Type No	SP AM1 001 BA
Serial No	**3062**

Overall length	296 mm
Tip diameter	6.0 mm (at the tip)
Sensor offset	3.0 mm (centre of sensor from tip)
Internal Amplifier	20 dB

Manufacturer / Origin	Schmid & Partner Engineering AG, Zürich, Switzerland
Manufacturing date	Oct-2008
Last calibration date	June 16, 2009

Calibration data

Connector rotation angle	(in DASY system)	**62.6** °	+/- 3.6 ° (k=2)
Sensor angle	(in DASY system)	**0.00** °	+/- 0.5 ° (k=2)
Sensitivity at 1 kHz	(in DASY system)	**0.00741 V / (A/m)**	+/- 2.2 % (k=2)

Calibration Laboratory of
Schmid & Partner
Engineering AG
Zeughausstrasse 43, 8004 Zurich, Switzerland

S Schweizerischer Kalibrierdienst
C Service suisse d'étalonnage
S Servizio svizzero di taratura
Swiss Calibration Service

Accredited by the Swiss Accreditation Service (SAS)
The Swiss Accreditation Service is one of the signatories to the EA Multilateral Agreement for the recognition of calibration certificates

Accreditation No.: SCS 108

Client RTS (RIM Testing Services) **Certificate No: TMFS_1003_Jan10**

CALIBRATION CERTIFICATE

Object / Identification	TMFS-1 – SN: 1003
Calibration procedure(s)	QA CAL-24.v2 Calibration procedure for AM1D magnetic field probes and TMFS in the audio range
Calibration date	January 22, 2010
Condition of the calibrated item	In Tolerance

This calibration certificate documents the traceability to national standards, which realize the physical units of measurements (SI).
The calibrations have been conducted in the R&D laboratory facility: environment temperature (22 ± 3)°C and humidity < 70%.

Calibration Equipment used (M&TE critical for calibration)

Primary Standards	ID #	Cal Date (Calibrated by, Certificate No.)	Scheduled Calibration
Keithley Multimeter Type 2001	SN: 0810278	1-Oct-09 (No: 9055)	Oct-10
Secondary Standards	**ID #**	**Cal / Check Date**	**Scheduled Calibration Check**
AMCC	1050	15-Oct-09 (in house check Oct-09)	Oct-11
Reference Probe AM1DV2	SN: 1008	21-Jan-10 (No. AM1D-1008_Jan10)	Jan-11
AMMI Audio Measuring Instrument	1062	14-Jul-09 (in house check Jul-09)	Jul-11
Agilent WF Generator 33120A	MY40005266	13-Oct-09 (in house check Oct-09)	Oct-11

	Name	Function	Signature
Calibrated by:	Mike Meili	Laboratory Technician	
Approved by:	Fin Bomholt	R&D Director	

Issued: January 25, 2010

This calibration certificate shall not be reproduced except in full without written approval of the laboratory.

References

[1] ANSI-PC63.19-2007
American National Standard for Methods of Measurement of Compatibility between Wireless Communications Devices and Hearing Aids.
[2] DASY4 manual, Chapter 29: Hearing Aid Compatibility (HAC) T-Coil Extension (April 2008)

Methods Applied and Interpretation of Parameters

- *Coordinate System:* The TMFS is mounted underneath the HAC Test Arch touching equivalently to a wireless device according to [2] 29.2.2.: In "North" orientation, the TMFS signal connector is directed to the north, with x and y axes of TMFS and Test arch coinciding (see fig. 1). The rotational symmetry axis of the TMFS is aligned to the center of the HAC test Arch. For East, South and West configuration, the TMFS has been rotated clockwise in steps of 90°, so the connector looks into the specified direction. The evaluation of the radial direction is referenced to the device orientation (x equivalent to South direction).

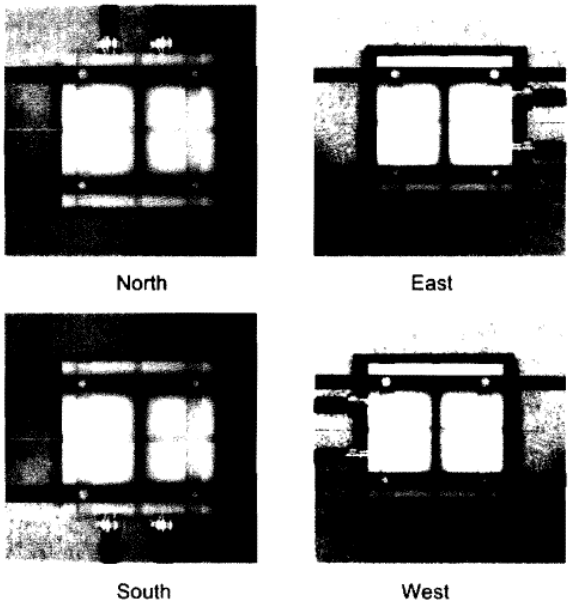


Fig. 1 TMFS scanning measurement configurations

- *Measurement Plane:* In coincidence with standard [1], the measurement plane (probe sensor center) is selected to be at a distance of 10 mm above the the surface of the TMFS touching the frame. The 50 x 50 mm scan area is aligned to the center of the unit. The scanning plane is verified to be parallel to the phantom frame before the measurements using the predefined "Geometry and signal check" procedure according to the predefined procedures described in [2].

- *Measurement Conditions:* Calibration of AM1D probe and AMMI are according to [2]. The 1 kHz sine signal for the level measurement is supplied from an external, independent generator via a BNC cable to TMFS IN and monitored at TMFS OUT with an independent RMS voltmeter or Audio Analyzer. The level is set to 0.5 Vrms and monitored during the scans.

- For the *frequency response*, a higher suppression of the background ambient magnetic field over the full frequency range was achieved by placing the TMFS in a magnetically shielded box. The AM1D probe was fixed without robot positioner near the axial maximum for this measurement. The background noise suppression was typ. 30 dB at 100 Hz (minimum) and 42 dB at 1 kHz. The predefined multisine signal (48k_multisine_50-10000_10s.wav) was used and evaluated in the third-octave bands from 100 Hz to 10000 Hz.

1 Measurement Conditions

DASY system configuration, as far as not given on page 1.

DASY Version	DASY5	V5.2 B162
DASY PP Version	SEMCAD	V14.0 B59
Phantom	HAC Test Arch	SD HAC P01 BA, #1002
Distance TMFS Top - Probe Centre	10 mm	
Scan resolution	dx, dy = 5 mm	area = 50 x 50 mm
Frequency	for field scans	1 kHz
Signal level to TMFS	for field scans	500 mV RMS
Signal	for frequency response	multisine signal 50-10000 Hz, each third-octave band

Table 1: System configuration

2 Axial Maximum Field

Configuration	East	South	West	North	Subset Average	Average
Axial Max	-20.17	-20.17	-20.16	-20.17		**-20.17**
TMFS Y Axis 1st Max	-25.74	-25.74	-25.70	-25.70		
TMFS Y Axis 2nd Max	-25.92	-25.66	-26.02	-25.7		
Longitudinal Max Avg	**-25.83**	**-25.70**	**-25.86**	**-25.70**	**-25.77**	
TMFS X Axis 1st Max	-25.73	-25.71	-25.73	-25.67		
TMFS X Axis 2nd Max	-25.68	-25.91	-25.67	-25.96		
Transversal Max Avg	**-25.71**	**-25.81**	**-25.70**	**-25.82**	**-25.76**	
Radial Max						**-25.77**

Table 2: Axial and radial field maxima measured with probe center at 10mm distance in dB A/m

The maximum was calculated as the average from the values measured in the 4 orientations listed in table 2.

Axial Maximum **-20.17 dB A/m** (+/- 0.33dB, k=2)

3 Radial Maximum Field

In addition, the average from the 16 maxima of the radial field listed in table 2 (measured at 10mm) was calculated:

Radial Maximum **-25.77 dB A/m**

4 Appendix

4.1 Frequency response

Max. deviation measured, relative to 1 kHz: **min. –0.03, max. +0.02 dB**

Frequency [Hz]	Response [dB]
100	0.02
125	0.00
160	-0.01
200	0.00
250	0.02
315	-0.01
400	0.00
500	0.00
630	0.00
800	0.00
1000	**0.00**
1250	-0.01
1600	-0.01
2000	-0.01
2500	-0.01
3150	-0.01
4000	-0.02
5000	-0.02
6300	-0.03
8000	-0.03
10000	-0.03

Table 3: Frequency response

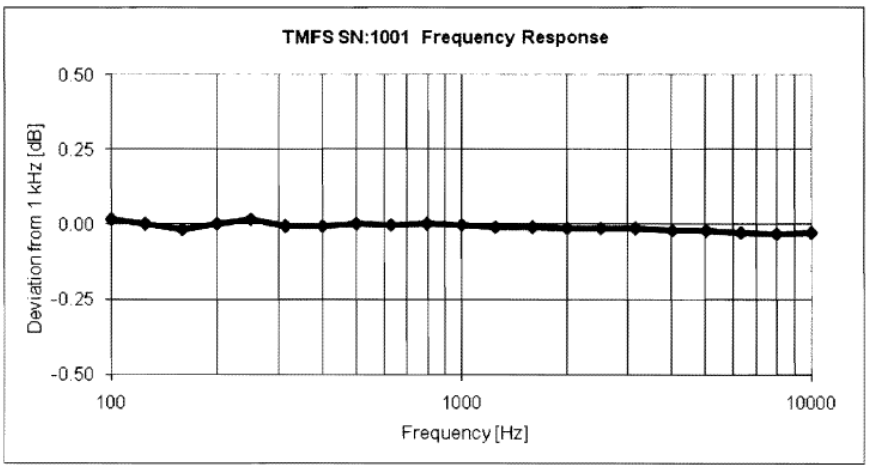


Fig. 2 Frequency response 100 to 10'000 Hz

4.2 Field plots

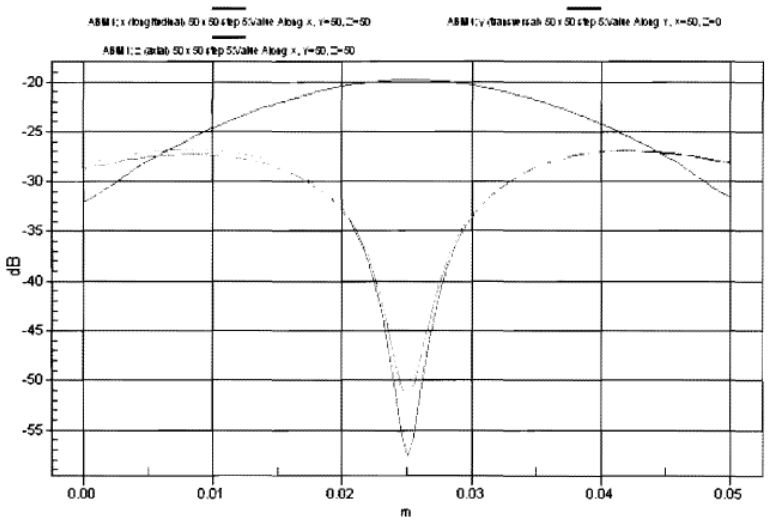


Fig. 3: Typical 2D field plots for x (red), y (green) and z (blue) components

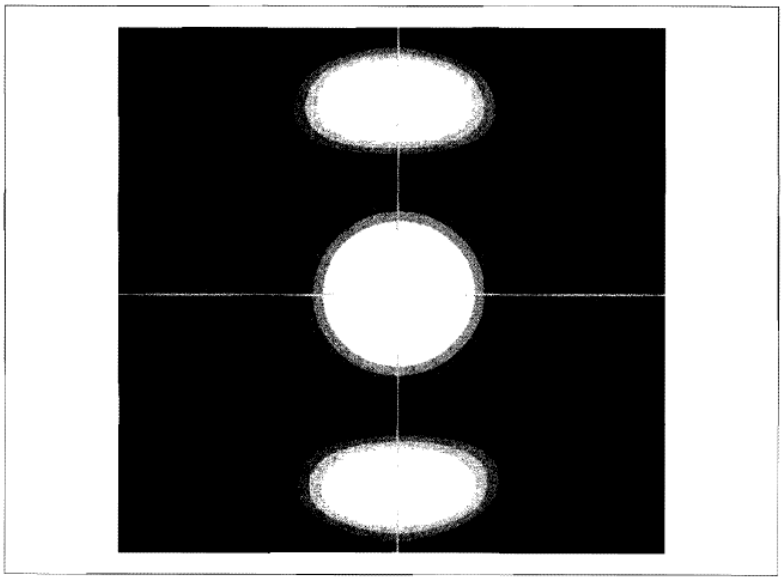


Fig. 4: Superponed field plots of z (axial), x and y radial magnetic field, 50 x 50 mm, individual scaling: white = max. field level, black = -4dB below max. The lines show the position of the 2D field plot of figure 3.

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Certificate of conformity

Item	Audio Magnetic Calibration Coil AMCC
Type No	**SD HAC P02 A**
Series No	1001 ff.
Manufacturer / Origin	Schmid & Partner Engineering AG Zurich, Switzerland

Description of the item
The Audio Magnetic Calibration coil (AMCC) is a Helmholtz Coil designed according to standard [1], section D.9 for calibration of the AM1D probe. Two horizontal coils are positioned above a non-metallic base plate and generate a homogeneous magnetic field in the z direction (normal to it).

Configuration
The AMCC consists of two parallel coils of 20 turns with radius 143 mm connected in parallel in a distance of 143 mm. With this design, a current of 10 mA produces a field of 1 A/m.
The DC input resistance at the input BNC socket is adjusted by a series resistor to a DC resistance of approximately 50 Ohm. The voltage required to produce a field of 1 A/m is consequently approx. 500 mV.
To current through the coil is monitored via a shunt resistor of 10 Ohm +/- 1%. The voltage is available on a BNO socket with 100 mV corresponding to 1 A/m.

Handling of the item
The coil shall be positioned in a non-metallic environment to avoid distortion of the magnetic field.

Tests

Test	Requirement	Details	Units tested
Number of turns	N = 20 per coil	Resistance measurment	all
Orientation of coils	parallel coils with same direction of windings	Magnetic field variation in the AMCC axis	all
Coil radius	r = 143 mm	mechanical dimension	First article
Coil distance	d = 143 mm distance between coil centers	mechanical dimension	First article
Input resistance	51.7 +/- 2 Ohm	DC resistance at BNC input connector	all
Shunt resistance	R = 10.0 Ohm +/- 1 %	DC resistance at BNO output connector	all
Shunt sensitivity	Hc = 1 A/m per 100 mV according to formula Hc = (U / R) * N / r / (1.25^1.5)	Field measurement compared with Narda ELT400 + BN2300/90.10	First article

Standards
[1] ANSI PC63.19-2006 Draft 3.12

Conformity
Based on the tests above, we certify that this item is in compliance with the requirements of [1].

Date 22.5.2006

Stamp / Signature

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Specifications

Audio Magnetic Field Probe AM1D

The AM1D probe is an active probe with a single sensor according to [1] section D.8. It is fully RF shielded and has a rounded tip of 6 mm diameter incorporating a pickup coil with its center offset 3mm from the tip and the sides.

SPEAG, the manufacturer of the T-Coil system tested the probe frequency response and its dynamic range. The compliance is stated in the Certificate of conformity document 880-SPAM1001A-A. Also the probe frequency has been verified and the response deviation from the ideal differentiator was within +0.05 and - 0.46 dB in the range 100 Hz to 10 kHz on the center frequencies of the third-octave bands. Note that it includes the probe preamplifier and also with the AMMI internal preamplifiers, filters and processing.

Dynamic range:
maximum + 21 dB A/m @ 1 kHz
Noise level typically -70 dB A/m @ 1 kHz
ABM2 typically -60 dB A/m

Linearity
Within < 0.1 dB from 5 dB
below limitation to 16 dB above noise level

Sensitivity
Typically -24 dBV / A/m @ 1 kHz probe output

Audio Magnetic Measurement Instrument (AMMI)
sampling rate 48 kHz / 24 bit
dynamic range 85 dB
test signal generation user selectable and predefined (via PC)
calibration auto-calibration / full system calibration using AMCC
with monitor output
dimensions 482 x 65 x 270 mm

Helmholtz Calibration Coil (AMCC)
dimensions 370 x 370 x 196 mm, according to ANSI-PC63.19
The Audio Magnetic Calibration coil is a Helmholtz Coil designed according to [1], section D.9 for calibration of the AM1D probe. The two horizontal coils generate a homogeneous magnetic field in the z direction.

Shunt sensitivity Hc = 1 A/m per 100mV according to formula:

Hc = (U / R) * N / r / (1.25 ^ 1.5)

Number of turns N = 20 per coil
Coil radius r = 143 mm
Shunt resistance R = 10.00 Ohm